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Tactile feedback system

Abstract

A tactile feedback system is provided, including a fixed part, a movable part, and a driving assembly. The fixed part is affixed to an electronic device. The movable part can move relative to the fixed part. The driving assembly is configured to drive the movable part to move relative to the fixed part, thereby generating a tactile feedback force to a user.

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Background/Summary

CROSS REFERENCE TO RELATED APPLICATIONS (1) This application claims the benefit of U.S. Provisional Application No. 63/143,344, filed Jan. 29, 2021, U.S. Provisional Application No. 63/230,990, filed Aug. 9, 2021, and U.S. Provisional Application No. 63/276,237, filed Nov. 5, 2021, the entirety of which are incorporated by reference herein.

BACKGROUND OF THE INVENTION

Field of the Invention

(1) The present invention relates to a tactile feedback system, and, in particular, to tactile feedback system that has a sensing module.

Description of the Related Art

(2) Conventional electronic devices (e.g. cell phones or tablet computers) usually have vibrators to provide tactile feedbacks to the users. As sensing technology has advanced, to expand the application of vibration tactile feedback becomes a challenge.

BRIEF SUMMARY OF THE INVENTION

(3) An embodiment of the present invention provides a tactile feedback system that includes a fixed part, a movable part, and a driving assembly. The fixed part is affixed to an electronic device. The movable part can move relative to the fixed part. The driving assembly is configured to drive the movable part to move relative to the fixed part, thereby generating a tactile feedback force to a user.

Description

BRIEF DESCRIPTION OF THE DRAWINGS

(1) The present invention can be more fully understood by reading the subsequent detailed description and examples with references made to the accompanying drawings, wherein:

(2) FIG. 1 is a perspective diagram of an electronic device 1-E in accordance with an embodiment of the invention. FIG. 2 is a perspective diagram of a tactile feedback system 1-1 and a sensing module 1-2 disposed in the electronic device 1-E of FIG. 1;

(3) FIG. 3 is a function block diagram of the tactile feedback system 1-1, the sensing module 1-2 and the CPU 1-C in the electronic device 1-E;

(4) FIG. 4 is a schematic diagram of a first curve 1-R1 that represents the relationship between the motion of the vibrator 1-12 measured by an external equipment and the second sensing signal 1-S2 generated by the sensing module 1-2, wherein the first curve 1-R1 deviates from a first target curve 1-R1';

(5) FIG. 5 is a perspective diagram of a tactile feedback system 1-1 and a sensing module 1-2 disposed in the electronic device 1-E, in accordance with another embodiment of the invention;

(6) FIG. 6 is a function block diagram of the tactile feedback system 1-1, the sensing module 1-2 and the CPU 1-C in the electronic device 1-E, in accordance with another embodiment of the invention; and

(7) FIG. 7 is a schematic diagram of a second curve 1-R2 that represents the relationship between the motion of the vibrator 1-12 measured by an external equipment and the third sensing signal 1-S3 generated by the sensor element 1-15, wherein the second curve 1-R2 deviates from a second target curve 1-R2'.

(8) FIG. 8 shows an exploded view of an optical component driving mechanism, according to certain aspects of the present disclosure.

(9) FIG. 9A is a perspective view of the optical component driving mechanism, according to certain aspects of the present disclosure.

(10) FIG. 9B is a bottom view of the optical component driving mechanism, according to certain aspects of the present disclosure.

(11) FIG. 10A is a bottom view of the base, according to certain aspects of the present disclosure.

(12) FIG. 10B is a bottom view of the first holder, according to certain aspects of the present disclosure.

(13) FIG. 11A is a cross-sectional view of the optical component driving mechanism, according to certain aspects of the present disclosure.

- (14) FIG. 11B is a cross-sectional view of the frame, according to certain aspects of the present disclosure.
- (15) FIG. 11C is a perspective view of the frame, according to certain aspects of the present disclosure.
- (16) FIG. 12 is a perspective view of the frame, the first magnetic component, the second magnetic component, the third magnetic component, the second circuit assembly, and the second sensing component, according to certain aspects of the present disclosure.
- (17) FIG. 13 shows a perspective view of the second circuit assembly, the second sensing component, and the strengthening assembly individually, according to certain aspects of the present disclosure.
- (18) FIG. 14 is a schematic diagram showing the first shock absorbing component, the second shock absorbing component, the third shock absorbing component, and the fourth shock absorbing component, according to certain aspects of the present disclosure.
- (19) FIG. 15 is a perspective view shows the first coil and the third coil embedded in the third circuit assembly with dash lines, according to certain aspects of the present disclosure.
- (20) FIG. 16A is a perspective view of the second holder, the second coil, and the second sensing component, according to certain aspects of the present disclosure.
- (21) FIG. 16B is a top view of the second holder, the second coil, and the second sensing component, according to certain aspects of the present disclosure.
- (22) FIG. 17A shows a perspective view of the first driving assembly, the second driving assembly, and the third driving assembly individually, according to certain aspects of the present disclosure.
- (23) FIG. 17B shows a top view of the first driving assembly, the second driving assembly, and the third driving assembly individually, according to certain aspects of the present disclosure.
- (24) FIG. 18A is a cross-sectional view of the first holder, the first optical component, the first circuit assembly, the third circuit assembly, the fourth circuit assembly, the base, the connecting portion, and the magnetically permeable component, according to certain aspects of the present disclosure.
- (25) FIG. 18B is a cross-sectional view taken along the dashed line A to A' in FIG. 18A, according to certain aspects of the present disclosure.
- (26) FIG. 18C shows a top view of the first driving assembly, the second driving assembly, and the third driving assembly individually, according to certain aspects of the present disclosure.
- (27) FIG. 19 is an exploded view of an optical component driving mechanism according to another embodiment of the present disclosure.
- (28) FIG. 20A shows a perspective view of the optical component driving mechanism of FIG. 19, according to certain aspects of the present disclosure, but for illustration purposes, the housing is not shown.
- (29) FIG. 20B shows a perspective view of the optical component driving mechanism of FIG. 19, according to certain aspects of the present disclosure, but for illustration purposes, the housing is not shown.
- (30) FIG. 21A is a schematic view of an optical module in some embodiments of the present disclosure.
- (31) FIG. 21B is a schematic view of some elements in FIG. 21A.
- (32) FIG. 21C is a schematic view of an optical module 3-1002 in some embodiments of the present disclosure.
- (33) FIG. 21D is a schematic view of some elements in FIG. 21C.
- (34) FIG. 22A is a schematic view of the light amount adjusting mechanism.
- (35) FIG. 22B is an exploded view of the light amount adjusting mechanism.
- (36) FIG. 23A is a schematic view of some elements of the light amount adjusting mechanism.
- (37) FIG. 23B is a top view of some elements of the light amount adjusting mechanism.
- (38) FIG. 23C is a top view of some elements of the light amount adjusting mechanism.

- (39) FIG. 23D is a top view of some elements of the light amount adjusting mechanism.
- (40) FIG. 24A to FIG. 24C are schematic views of some elements of the light amount adjusting mechanism when the movable portion rotates in the clockwise direction
- (41) FIG. 25A to FIG. 25C are schematic views of some elements of the light amount adjusting mechanism when the movable portion rotates in the counterclockwise direction.
- (42) FIG. 26 is a schematic view of a light amount adjusting mechanism in some embodiments of the present disclosure.
- (43) FIG. 27 is an exploded view of the optical element driving mechanism, according to some embodiments of the present disclosure.
- (44) FIG. 28 is a perspective view of the optical element driving mechanism, according to some embodiments of the present disclosure.
- (45) FIG. 29 is a top view of the optical element driving mechanism, according to some embodiments of the present disclosure, wherein the case and the first movable portion are omitted.
- (46) FIG. 30 is a front view of the optical element driving mechanism, according to some embodiments of the present disclosure, wherein the case and the first movable portion are omitted.
- (47) FIG. 31 is a top view of the optical element driving mechanism, according to some embodiments of the present disclosure, wherein the case is omitted.
- (48) FIG. 32 is a left side view of the optical element driving mechanism, according to some embodiments of the present disclosure.
- (49) FIG. 33 shows a perspective view of a haptic feedback system in accordance with some embodiments of the present disclosure;
- (50) FIG. 34 shows an exploded view of the haptic feedback system in accordance with some embodiments of the present disclosure;
- (51) FIG. 35 shows a perspective view of the interior of the haptic feedback system in accordance with some embodiments of the present disclosure;
- (52) FIG. 36 shows a top view of the interior of the haptic feedback system in accordance with some embodiments of the present disclosure;
- (53) FIG. 37 shows a bottom view of a frame of a mode adjustment assembly in accordance with some embodiments of the present disclosure;
- (54) FIG. 38 shows a cross-sectional view of the haptic feedback system along line 5-A-5-A shown in FIG. 33 in accordance with some embodiments of the present disclosure;
- (55) FIG. 39 shows a perspective view of an adjustment element in accordance with some embodiments of the present disclosure; and
- (56) FIG. 40 shows a cross-sectional view of the adjustment element along line 5-B-5-B shown in FIG. 35 in accordance with some embodiments of the present disclosure.
- (57) FIG. 41 is a perspective view of a haptic feedback system according to an embodiment of the present disclosure.
- (58) FIG. 42 is an exploded view of a haptic feedback system according to an embodiment of the present disclosure.
- (59) FIG. 43 is a cross-sectional view of the haptic feedback system cut along the line 6-A-6-A in FIG. 41.
- (60) FIG. 44 is a schematic diagram of partial elements of a haptic feedback system according to an embodiment of the present disclosure.
- (61) FIG. 45 is a schematic diagram of partial elements of a haptic feedback system according to an embodiment of the present disclosure.

DETAILED DESCRIPTION OF THE INVENTION

(62) The making and using of the embodiments of the tactile feedback system are discussed in detail below. It should be appreciated, however, that the embodiments provide many applicable inventive concepts that can be embodied in a wide variety of specific contexts. The specific embodiments discussed are merely illustrative of specific ways to make and use the embodiments,

and do not limit the scope of the disclosure.

(63) Unless defined otherwise, all technical and scientific terms used herein have the same meaning as commonly understood by one of ordinary skill in the art to which this invention belongs. It should be appreciated that each term, which is defined in a commonly used dictionary, should be interpreted as having a meaning conforming to the relative skills and the background or the context of the present disclosure, and should not be interpreted in an idealized or overly formal manner unless defined otherwise.

(64) In the following detailed description of the preferred embodiments, reference is made to the accompanying drawings, and in which specific embodiments of which the invention may be practiced are shown by way of illustration. In this regard, directional terminology, such as “top,” “bottom,” “left,” “right,” “front,” “back,” etc., is used with reference to the orientation of the figures being described. The components of the present invention can be positioned in a number of different orientations. As such, the directional terminology is used for the purposes of illustration and is in no way limiting.

(65) The first embodiment of the present disclosure is described below.

(66) FIG. 1 is a perspective diagram of an electronic device 1-E in accordance with an embodiment of the invention. FIG. 2 is a perspective diagram of a tactile feedback system 1-1 and a sensing module 1-2 disposed in the electronic device 1-E of FIG. 1.

(67) Referring to FIGS. 1 and 2, the electronic device 1-E in this embodiment may be a cell phone or a tablet computer that comprises a housing 1-E0 and a screen 1-E1 disposed on the housing 1-E0. Specifically, a sensing module 1-2 is disposed on a lower side of the housing 1-E0. The sensing module 1-2 may constitute at least a part of a touch pad, a button or other user interface of the electronic device 1-E. In some embodiments, the sensing module 1-2 may comprise an Optical Finger Navigation (OFN) sensor, gyroscope, accelerometer, tactile switch, fingerprint sensor, pressure sensor, sound wave sensor, gas sensor, temperature sensor, or gas concentration sensor, not limited to the embodiments of the invention.

(68) As shown in FIG. 2, a tactile feedback system 1-1 is connected to the sensing module 1-2 and accommodated in the housing 1-E0 of the electronic device 1-E. The tactile feedback system 1-1 primarily comprises a fixed part 1-11 (including a frame 1-111 and a flat base 1-112), a vibrator 1-12 (movable part), a control unit 1-13, and a circuit assembly 1-14. The frame 1-111 is affixed in the housing 1-E0, and the base 1-112 is affixed to the bottom of the frame 1-111. The vibrator 1-12 can move in the frame 1-111 to provide vibration feedback (tactile feedback force) to the users.

(69) It should be noted that the sensing module 1-2, the circuit assembly 1-14, and the control unit 1-13 on the circuit assembly 1-14 are all affixed to the base 1-112 and located outside the frame 1-111. The sensing module 1-2 and the control unit 1-13 can be electrically connected to a CPU of the electronic device 1-E via the circuit assembly 1-14.

(70) In some embodiments, the sensing module 1-2 can also be disposed in other positions of the electronic device 1-E. For example, the sensing module 1-2 can be disposed on the housing 1-E0, on a circuit board (not shown) or on a flat member that is received in the housing 1-E0. Moreover, the frame 1-111 and the circuit assembly 1-14 may also be affixed to the housing 1-E0 or a flat member (e.g. circuit board) that is received in the housing 1-E0, not limited to the embodiments of the invention.

(71) The control unit 1-13 may comprise a controller IC, and it can transmit a control signal through the circuit assembly 1-14 to a driving assembly (not shown) in the frame 1-111, thereby driving the vibrator 1-12 (movable part) to vibrate relative to the frame 1-111.

(72) In this embodiment, the driving assembly may comprise a coil disposed on the frame 1-111 and a magnet disposed on the vibrator 1-12. When an electrical current (control signal) is applied to the coil, the magnet and the vibrator 1-12 can be driven to move relative to the frame 1-111. For example, the fixed part 1-11, the vibrator 1-12 (movable part), and the driving assembly constitute at least a part of a linear resonant actuator (LRA) in the electronic device 1-E.

(73) FIG. 3 is a function block diagram of the tactile feedback system **1-1**, the sensing module **1-2** and the CPU **1-C** in the electronic device **1-E**. As shown in FIG. 3, the sensing module **1-2** can detect the posture, velocity, acceleration of the electronic device **1-E** or the user's input (e.g. touch or click) and then output a first sensing signal **1-S1** to the CPU **1-C** in the electronic device **1-E** accordingly. Subsequently, the CPU **1-C** transmits a command signal **1-C1** to the control unit **1-13** according to the first sensing signal **1-S1**, whereby the control unit **1-13** can be adjusted to a specific control mode. In this embodiment, when different postures of the electronic device **1-E** are detected, the vibrator **1-12** can be driven to vibrate at different amplitudes correspondingly. That is, the control unit **1-13** can output control signals of different modes according to the command signal **1-C1**, thereby providing various kinds of tactile feedbacks to the users.

(74) Additionally, the sensing module **1-2** can further transmit a second sensing signal **1-S2** to the control unit **1-13** by detecting the posture, velocity, or acceleration of the electronic device **1-E**, and the second sensing signal **1-S2** does not pass through the CPU **1-C**. In this embodiment, the second sensing signal **1-S2** may be greater than, less than or equal to the first sensing signal **1-S1**.

(75) It should be noted that the control unit **1-13** can output the control signal to the driving assembly (e.g. the coil disposed on the frame **1-111**) according to both of the command signal **1-C1** and the second sensing signal **1-S2**. Thus, the vibrator **1-12** can be driven to move relative to the frame **1-111** and provide appropriate vibration feedback to the users.

(76) FIG. 4 is a schematic diagram of a first curve **1-R1** that represents the relationship between the motion of the vibrator **1-12** measured by an external equipment and the second sensing signal **1-S2** generated by the sensing module **1-2**, wherein the first curve **1-R1** deviates from a first target curve **1-R1'**.

(77) In this embodiment, an external equipment (not shown) can be used to measure a motion (e.g. displacement, velocity, or acceleration) of the vibrator **1-12** relative to the frame **1-111**. Hence, a first curve **1-R1** (FIG. 4) can be obtained that represents the relationship between the motion of the vibrator **1-12** measured by the external equipment and the second sensing signal **1-S2** that is generated by the sensing module **1-2** detecting the motion of the vibrator **1-12**.

(78) Before the calibration process of the sensing module **1-2** is performed, the first curve **1-R1** may deviate from a first target curve **1-R1'** as shown in FIG. 4. To address the deficiency, the external equipment can modify a setting parameter of the control unit **1-13** according to the first curve **1-R1**, so as to achieve high motion control accuracy and efficiency of the vibrator **1-12** relative to the frame **1-111**.

(79) After the calibration process of the sensing module **1-2** (second sensing signal **1-S2**), the tactile feedback system **1-1** can perform accurate closed-loop motion or amplitude control of the vibrator **1-12** according to the second sensing signal **1-S2**, thus providing appropriate and precise vibration feedback to the users. It should be noted that the calibration process does not involve the CPU **1-C** of the electronic device **1-E**.

(80) FIG. 5 is a perspective diagram of a tactile feedback system **1-1** and a sensing module **1-2** disposed in the electronic device **1-E**, in accordance with another embodiment of the invention. FIG. 6 is a function block diagram of the tactile feedback system **1-1**, the sensing module **1-2** and the CPU **1-C** in the electronic device **1-E**, in accordance with another embodiment of the invention. FIG. 7 is a schematic diagram of a second curve **1-R2** that represents the relationship between the motion of the vibrator **1-12** measured by an external equipment and the third sensing signal **1-S3** generated by the sensor element **1-15**, wherein the second curve **1-R2** deviates from a second target curve **1-R2'**.

(81) FIGS. 5-7 is different from the embodiment of FIGS. 2-4 in that a sensor element **1-15** (FIG. 5) is provided in the frame **1-111** to detect the motion of the vibrator **1-12** relative to the frame **1-111**, and the sensor element **1-15** can transmit a third sensing signal **1-S3** to the control unit **1-13** accordingly (FIG. 6).

(82) In some embodiments, the sensor element **1-15** may also be directly disposed on the frame **1-**

111 or the base **1-112**, not limited to the embodiments of the invention. Here, the sensor element **1-15** may comprise a Hall sensor.

(83) As shown in FIG. 6, the control unit **1-13** can output a control signal to the driving assembly according to the command signal **1-C1**, the second sensing signal **1-S2**, and the third sensing signal **1-S3** thereby driving the vibrator **1-12** (movable part) to vibrate relative to the frame **1-111** and providing precise vibration feedback to the users.

(84) In this embodiment, an external equipment (not shown) can be used to measure a motion (e.g. displacement, velocity, or acceleration) of the vibrator **1-12** relative to the frame **1-111**. Hence, a second curve **1-R2** (FIG. 7) can be obtained that represents the relationship between the motion of the vibrator **1-12** measured by the external equipment and the third sensing signal **1-S3** that is generated by the sensor element **1-15** detecting the motion of the vibrator **1-12**.

(85) Before the calibration process of the sensing module **1-2** is performed, the second curve **1-R2** may deviate from a second target curve **1-R2'** as shown in FIG. 7. To address the deficiency, the external equipment can modify a setting parameter of the control unit **1-13** according to the first curve **1-R1** and the second curve **1-R2**, so as to achieve high motion control accuracy and efficiency of the vibrator **1-12** relative to the frame **1-111**.

(86) After the calibration process of the sensing module **1-2** (second and third sensing signals **1-S2** and **1-S3**), the tactile feedback system **1-1** can perform accurate closed-loop motion or amplitude control of the vibrator **1-12** according to the second and third sensing signals **1-S2** and **1-S3**, thus providing comfortable and precise vibration feedback to the users. It should be noted that the calibration process does not involve the CPU **1-C** of the electronic device **1-E**.

(87) In some embodiments, the sensing module **1-2** may comprise gyroscope and/or accelerometer to detect the posture of the electronic device **1-E**. When the second sensing signal **1-S2** meets a first condition (e.g. the sensing module **1-2** detects the electronic device **1-E** is oriented upward), the control unit **1-13** controls the vibrator **1-12** to move in a first mode (e.g. continuous vibration) via the driving assembly. In contrast, when the second sensing signal **1-S2** meets a second condition (e.g. the sensing module **1-2** detects the electronic device **1-E** is oriented downward), the control unit **1-13** controls the vibrator **1-12** to move in a second mode (e.g. intermittent vibration) via the driving assembly.

(88) The second embodiment of the present disclosure is described below.

(89) The optical component driving mechanism of the embodiment of the present invention is described below. However, it can be easily understood that the embodiments of the present invention provide many suitable inventive concepts and can be implemented in a wide variety of specific backgrounds. The specific embodiments disclosed are only used to illustrate the use of the present invention in a specific method, and are not used to limit the scope of the present invention. Unless otherwise defined, all terms used here (including technical and scientific terms) have the same meanings commonly understood by the general artisans to whom the disclosures in this article belong. It is understandable that these terms, such as the terms defined in commonly used dictionaries should be interpreted as having a meaning consistent with the relevant technology and the background or context of this disclosure, and should not be interpreted in an idealized or excessively formal way, unless specifically defined herein.

(90) FIG. 8 shows an exploded view of an optical component driving mechanism **2-10**, according to certain aspects of the present disclosure. The aforementioned optical component driving mechanism **2-10** may be disposed inside an electronic device such as a camera, a tablet computer, or a mobile phone, to obtain images. The aforementioned optical component driving mechanism **2-10** may relatively move both the first optical component **2-1** and the second optical component (not shown) disposed therein, so as to achieve the purpose of auto-focusing (AF) and optical image stabilization (OIS). The detailed structure of the optical component driving mechanism **2-10** is described below.

(91) As shown in FIG. 1, the optical component driving mechanism **2-10** includes a fixed portion

2-100, a first movable portion **2-200**, a second movable portion **2-300**, a connecting portion **2-400**, a first driving assembly **2-500**, a second driving assembly **2-510**, a third driving assembly **2-520**, a first supporting assembly **2-600**, a second supporting assembly **2-650**, a sensing assembly **2-700**, a strengthening assembly **2-800** (shown in FIG. 13), three magnetically permeable components **2-900** (shown in FIG. 18A to 11C), a first shock absorbing component **2-1000** (shown in FIG. 14), a second shock absorbing component **2-1010** (shown in FIG. 14), a third shock absorbing component **2-1020** (shown in FIG. 14), and a fourth shock absorbing component **2-1030** (shown in FIG. 14).

(92) The fixed portion **2-100** includes a housing **2-110**, a frame **2-120**, and a base **2-130**. The housing **2-110** has a plate-like structure, and the housing **2-110** is fixedly connected to the frame **2-120**. The base **2-130** is fixedly connected to the frame **2-120**. Details regarding the frame **2-120** are described in FIGS. 11A to 11C. In addition, the first movable portion **2-200** includes a first circuit assembly **2-220**. The fixed portion **2-100** further includes a second circuit assembly **2-140**.

(93) The first circuit assembly **2-220** has a plate-like structure. The second circuit assembly **2-140** is disposed on the frame **2-120**. The second circuit assembly **2-140** includes a first portion **2-141** and a second portion **2-142**. Both the first portion **2-141** and the second portion **2-142** have a plate-like structure, and the first portion **2-141** and the second portion **2-142** are not parallel to each other.

(94) The first movable portion **2-200** further includes a first holder **2-210**, a third circuit assembly **2-230**, and a fourth circuit assembly **2-240**. The first holder **2-210** is fixedly connected to the first circuit assembly **2-220**. The second movable portion **2-300** includes a second holder **2-310**.

(95) The first holder **2-210** is configured to connect a first optical component **2-1**, and the second holder **2-310** is configured to connect a second optical component (not shown). In this embodiment, the first optical component **2-1** is configured to receive electromagnetic waves and output signals. The first optical component **2-1** and the second optical component may be optical components such as a photosensitive component, a camera lens, a lens, etc.

(96) The first optical component **2-1** has a first optical axis **2-O1**, and the second optical component has a second optical axis **2-O2**. In this embodiment, the first optical axis **2-O1**, the second optical axis **2-O2**, and a main axis **2-D1** are substantially parallel. The first optical component **2-1** and the first circuit assembly **2-220** at least partially overlap when viewed along the first optical axis **2-O1**. The first optical component **2-1** is electrically connected to the first circuit assembly **2-220**.

(97) Both the third circuit assembly **2-230** and the fourth circuit assembly **2-240** have a plate-like structure. The third circuit assembly **2-230** is disposed on the fourth circuit assembly **2-240**. The third circuit assembly **2-230** is electrically connected to the first circuit assembly **2-220** via the fourth circuit assembly **2-240**.

(98) The optical component driving mechanism **2-10** may achieve the effect of optical image stabilization through the movement of the first movable portion **2-200** relative to the fixed portion **2-100**. The optical component driving mechanism **2-10** may achieve the effect of auto-focusing through the movement of the second movable portion **2-300** relative to the fixed portion **2-100**.

(99) The optical component driving mechanism **2-10** carries the first optical component **2-1** and the second optical component (not shown). When the light from the outside enters the optical component driving mechanism **2-10**, the incident light passes through from the light incident end (near the housing) to the light exit end. Between the light incident end to the light exit end, along the second optical axis of the second optical component, the light passes through the second optical component disposed in the optical component driving mechanism **2-10**, and then to the first optical component **2-1** to obtain image. The connecting portion **2-400** is configured to connect the first circuit assembly **2-220** to an external circuit (not shown), wherein the first circuit assembly **2-220** or the connecting portion **2-400** may be connected to the external circuit through a flexible printed circuit board or TSA+ technique.

(100) The first driving assembly **2-500** includes four first magnetic components **2-501** and four first

coils **2-502**. The second driving assembly **2-510** includes four second magnetic components **2-511** and four second coils **2-512**. The third driving assembly **2-520** includes two third magnetic components **2-521** and two third coils **2-522**.

(101) The first magnetic component **2-501** and the second magnetic component **2-511** have an integrated structure, that is to say, the first magnetic component **2-501** and the second magnetic component **2-511** are not two separate components, and the first magnetic component **2-501** is also the second magnetic component element **2-511**. In this way, the volume of the optical component driving mechanism **2-10** may be reduced to achieve miniaturization.

(102) The first magnetic components **2-501**, the second magnetic components **2-511**, and the third magnetic components **2-521** are disposed on the frame **2-120**. The first coils **2-502** and the third coils **2-522** are embedded in the third circuit assembly **2-230**. The second coils **2-512** are disposed on the second holder **2-310**.

(103) The first driving assembly **2-500** is electrically connected to the first circuit assembly **2-220**. The second driving assembly **2-510** is electrically connected to the second circuit assembly **2-140**. The first driving assembly **2-500** is configured to drive the first holder **2-210** to move relative to the frame **2-120** in a first dimension. The first dimension is movement in the plane formed by a second axis **2-D2** and a third axis **2-D3**. The second driving assembly **2-510** is configured to drive the second holder **2-310** to move relative to the frame **2-120** in a second dimension. The second dimension is movement along the second optical axis **2-O2**.

(104) One of the features of the present disclosure is that the optical component driving mechanism **2-10** in the present disclosure includes a third driving assembly **2-520**. The third driving assembly **2-520** is configured to drive the first holder **2-210** to move relative to the frame **2-120** in a third dimension. The third dimension is rotation with a rotation axis as the axle center, and the rotation axis is parallel to the first optical axis **2-O1**.

(105) The first support assembly **2-600** may support the first holder **2-210** to move relative to the frame **2-120**. The first support assembly **2-600** includes four support components **2-601**. In this embodiment, the four support components **2-601** are all balls.

(106) The second support assembly **2-650** may support the movement of the second holder **2-310** relative to the frame **2-120**. The second support assembly **2-650** includes a first elastic component **2-651** and a second elastic component **2-652**. The first support assembly **2-600** partially overlaps the second support assembly **2-650** when viewed along the first optical axis **2-O1**. The second holder **2-310** is movably connected to the frame **2-120** via the first elastic component **2-651** and the second elastic component **2-652**.

(107) The sensing assembly **2-700** includes three first sensing components **2-710**, one second sensing component **2-720**, and two sensing magnets **2-730**. The second sensing component **2-720** cannot be seen in the viewing angle of FIG. 8, the configuration of the second sensing component **2-720** on the second circuit assembly **2-140** is described in detail with respect to FIG. 12 to FIG. 13.

(108) The aforementioned first sensing components **2-710** and the second sensing component **2-720** may be Hall effect sensors, and the sensing magnet **2-730** may be a permanent magnet. The Hall effect sensor may determine the position of the permanent magnet by detecting the change of the magnetic field of the permanent magnet, thereby increasing the accuracy of compensation or focusing.

(109) In another embodiment, other types of alignment components/assemblies, such as a magnetoresistive sensor (MRS) or an optical sensor, may also be used to detect the relative position of the first movable portion **2-200** and the second movable portion **2-300**.

(110) The first sensing components **2-710** are configured to sense the movement of the first holder **2-210**. The first sensing components **2-710** are disposed on the fourth circuit assembly **2-240** and are electrically connected to the fourth circuit assembly **2-240**. The second sensing component **2-720** is configured to sense the movement of the second holder **2-310**. The second sensing

component **2-720** is electrically connected to the second circuit assembly **2-140**. The second sensing component **2-720** is disposed on the first portion **2-141** of the second circuit assembly **2-140**.

(111) The first sensing components **2-710** and the second sensing component **2-720** do not overlap when viewed in any direction perpendicular to the main axis **2-D1**. The sensing magnets **2-730** are disposed on the opposite sides of the second holder **2-310**, the details of which will be shown in FIGS. **16A** to **16B**.

(112) FIG. **9A** is a perspective view of the optical component driving mechanism **2-10**, according to certain aspects of the present disclosure. The housing **2-110**, the frame **2-120**, the second portion **2-142** of the second circuit assembly **2-140**, the connecting portion **2-400**, and a portion of the base **2-130** can be seen in FIG. **9A**. The base **2-130** is fixedly connected to the frame **2-120**.

(113) FIG. **9B** is a bottom view of the optical component driving mechanism **2-10**, according to certain aspects of the present disclosure. The first circuit assembly **2-200** is electrically connected to the connecting portion **2-400**. The first circuit assembly **2-220** is fixedly connected to the first holder **2-210**.

(114) FIG. **10A** is a bottom view of the base **2-130**, according to certain aspects of the present disclosure. FIG. **10B** is a bottom view of the first holder **2-210**, according to certain aspects of the present disclosure. The base **2-130** includes a second opening **2-131** and four stopper portions **2-132**. The base **2-130** is made of metal material. The first holder **2-210** includes a first opening **2-211**, four avoidance portions **2-212**, and four recess portions **2-213**. The first holder **2-210** is made of non-metallic materials, such as plastic, fiberglass, or rubber, etc. Since the recess portion **2-213** cannot be seen in the viewing angle of FIG. **10B**, the recess portion **2-213** is described in detail with respect to FIGS. **11A** to **11B**.

(115) The first opening **2-211** and the second opening **2-131** correspond to the first optical axis **2-O1** of the first optical component **2-1**. The avoidance portion **2-212** is a groove structure for corresponding to the stopper portion **2-132**. The stop portion **2-132** is configured to limit the range of motion of the first holder **2-210**.

(116) In detail, the stopper portion **2-132** is disposed in the avoidance portion **2-212**, which has a groove structure. Therefore, when the first holder **2-210** is driven by the first driving assembly **2-500** or the third driving assembly **2-520** (FIG. **8**) to move, the movement of the first holder **2-210** is limited by the stopper portion **2-132**.

(117) FIG. **11A** is a cross-sectional view of an optical component driving mechanism **2-10**, according to certain aspects of the present disclosure. FIG. **11B** is a cross-sectional view of a frame **2-120**, according to certain aspects of the present disclosure. FIG. **11C** is a perspective view of a frame **2-120**, according to certain aspects of the present disclosure. FIG. **11A** and FIG. **11B** is a cross-sectional view, which observed along a first axis **2-S1** as viewing angles. The first axis **2-S1** is an axis located on the plane formed by the second axis **2-D2** and the third axis **2-D3**. Both the included angle between the first axis **2-S1** and the second axis **2-D2** and the included angle between the first axis **2-S1** and the third axis **2-D3** are 45 degrees. The relationships among the first axis **2-S1**, the second axis **2-D2** and the third axis **2-D3** are shown more clearly in FIG. **17B**.

(118) Referring to FIGS. **11A** to **11C** together, the frame **2-120** includes two first sides **2-121**, two second sides **2-122**, four corners **2-123**, a first accommodating space **2-124**, a second accommodating space **2-125**, a third accommodating space **2-126**, four frame protrusions **2-127**, and four inner walls **2-128**.

(119) The first sides **2-121** are two opposite sides of the frame **2-120**, and the second sides **2-122** are the other two opposite sides of the frame **2-120**. The first sides **2-121** extend along the second axis **2-D2**. The first side **2-121** and the second side **2-122** are adjacent and perpendicular to each other. The four corners **2-123** are each located at the junction of the first side **2-121** and the second side **2-122**. When viewed along the main axis **2-D1**, the support components **2-601** of the first support assembly **2-600** each located at four corners **2-123** of the frame **2-120**.

(120) The first accommodating space **2-124** is configured to accommodate the first holder **2-210**. The first accommodating space **2-124** is adjacent to the base **2-130**. The second accommodating space **2-125** is configured to accommodate the second holder **2-310** and the second optical component (not shown). The third accommodating space **2-126** is adjacent to the housing **2-110**. The first elastic component **2-651** is located in the third accommodating space **2-126**.

(121) The main axis **2-D1** passes through the first accommodating space **2-124**, the second accommodating space **2-125**, and the third accommodating space **2-126**. The second accommodating space **2-125** is connected with the first accommodating space **2-124** and the third accommodating space **2-126**, respectively. When viewed along the first optical axis **2-O1**, the stopper portion **2-132** and the first holder **2-210** and the first circuit assembly **2-220** at least partially overlap.

(122) The frame protrusion **2-127** has a first frame surface **2-1271** and a second frame surface **2-1272**. The first frame surface **2-1271** and the second frame surface **2-1272** face in opposite directions. The first frame surface **2-1271** faces the first accommodating space **2-124**. The second frame surface **2-1272** faces the third accommodating space **2-126**.

(123) When viewed along the main axis **2-D1**, the first frame surface **2-1271** and the second frame surface **2-1272** partially overlap. The frame protrusion **2-127** is adjacent to the second accommodation space **2-125**. The inner walls **2-128** have inner surfaces **2-1280**, and the frame protrusions **2-127** protrude from the inner walls **2-128**. The frame protrusions **2-127** overlap the second accommodation space **2-124** when viewed along the first axis **2-S1**.

(124) The support components **2-601** are located at the corners **2-123** of the frame **2-120**. The first magnetic components **2-501** are located at the corners **2-123** when viewed along the main axis **2-D1**. The corners **2-123** are adjacent to the first sides **2-121** when viewed along the main axis **2-D1**.

(125) In the present embodiment, the support components **2-601** are positioned in the recess portions **2-213**. The support components **2-601** contact the frame **2-120** and the first holder **2-210** respectively, so as to assist the first holder **2-210** to move relative to frame **2-120** when the first driving assembly **2-500** (FIG. 8) or the third driving assembly **2-520** (FIG. 8) drives the first holder **2-210**.

(126) As shown in FIG. 11A, the stopper portion **2-132** is positioned in the groove structure of the avoidance portion **2-212**. When the first movable portion **2-200** are driven by the first driving assembly **2-500** (FIG. 8) or the third driving assembly **2-520** (FIG. 8), and move to a limit position, the avoidance portion **2-212** will contact the stopper portion **2-132** and limit the first movable portion **2-200** within a certain range of movement.

(127) FIG. 12 is a perspective view of the frame **2-120**, the first magnetic component **2-501**, the second magnetic component **2-511**, the third magnetic component **2-521**, the second circuit assembly **2-140**, and the second sensing component **2-720**, according to certain aspects of the present disclosure. FIG. 13 shows a perspective view of the second circuit assembly **2-140**, the second sensing component **2-720**, and the strengthening assembly **2-800** individually, according to certain aspects of the present disclosure.

(128) As shown in FIG. 12, the frame protrusion **2-127** positions the first magnetic component **2-501** and the second magnetic component **2-511**, which have an integrated structure. The first magnetic components **2-501** and the second magnetic components **2-511** having an integrated structure are each located at the corners **2-123** of the frame **2-120**.

(129) The two third magnetic components **2-521** are each located on the two first sides **2-121**, although only one third magnetic component **2-521** can be seen in the viewing angle of FIG. 12. In this embodiment, the third magnetic component **2-521** is disposed on the frame **2-120**, but in different embodiments, the third magnetic component **2-521** may be disposed on the second holder **2-310** or the frame **2-120**.

(130) The second sensing component **2-720** is disposed on the first portion **2-141**. The second circuit assembly **2-140** is electrically connected to the second driving assembly **2-510** (FIG. 8) and

the second sensing component **2-720**. The second driving assembly **2-510** is electrically connected to the second circuit assembly **2-140** via the first elastic component **2-651** (FIG. 8).

(131) Referring to FIG. 12 to FIG. 13 together, the strengthening assembly **2-800** is made of a metal material. The strengthening assembly **2-800** is fixedly connected to the frame **2-120**. The second driving assembly **2-510** is electrically connected to the second circuit assembly **2-140** via the strengthening assembly **2-800**. In this embodiment, the strengthening assembly **2-800** is embedded in the frame **2-120**, and this configuration may achieve the effect of miniaturization.

(132) For illustration purposes, FIG. 14 is a schematic diagram showing a first shock absorbing component **2-1000**, a second shock absorbing component **2-1010**, a third shock absorbing component **2-1020**, and a fourth shock absorbing component **2-1030**. The first shock absorbing component **2-1000**, the second shock absorbing component **2-1010**, and the third shock absorbing component **2-1020** are configured to restrain the abnormal movement of the first movable portion **2-200**. The fourth shock absorbing component **2-1030** is configured to restrain the abnormal movement of the first movable portion **2-200** and the second movable portion **2-300**.

(133) The first shock absorbing component **2-1000**, the second shock absorbing component **2-1010**, the third shock absorbing component **2-1020**, and the fourth shock absorbing component **2-1030** have flexibility, and are all made of non-metallic materials. In this embodiment, the first shock absorbing component **2-1000**, the second shock absorbing component **2-1010**, the third shock absorbing component **2-1020**, and the fourth shock absorbing component **2-1030** may be gels.

(134) As shown in FIG. 14, the first shock absorbing component **2-1000** is located in the first accommodating space **2-124**. The first shock absorbing component **2-1000** is in direct contact with the third circuit assembly **2-230** of the first movable portion **2-200** and the frame **2-120** of the fixed portion **2-100**. The second shock absorbing component **2-1010** is in direct contact with the first holder **2-210** of the first movable portion **2-200** and the frame **2-120** and the base **2-130** of the fixed portion **2-100**.

(135) As shown in FIG. 14, the third shock absorbing component **2-1020** is located in the groove structure of the avoidance portion **2-212**, and the third shock absorbing component **2-1020** is in direct contact with the first holder **2-210** of the first movable portion **2-200**, the first circuit assembly **2-140** and the base **2-130**. The fourth shock absorbing component **2-1030** is in direct contact with the third circuit assembly **2-230** of the first movable portion **2-200** and the second holder **2-310** of the second movable portion **2-300**.

(136) FIG. 15 shows the first coils **2-502** and the third coils **2-522** embedded in the third circuit assembly **2-230** with dash lines. The support components **2-601** are disposed in the recess portion **2-213** on the first holder **2-210**. The first sensing component **2-710** is disposed on the fourth circuit assembly **2-240**.

(137) The first magnetic components **2-501** (FIG. 8) disposed on the frame **2-120** correspond to the first coils **2-502** disposed on the third circuit assembly **2-230** to drive the first holder **2-210** (FIG. 8) in the first dimension. The third magnetic components **2-521** (FIG. 8) disposed on the frame **2-120** correspond to the third coils **2-522** disposed on the third circuit assembly **2-230** to drive the first holder **2-210** (FIG. 8) to move in the third dimension.

(138) FIG. 16A is a perspective view of the second holder **2-310**, the second coil **2-512**, and the sensing magnet **2-730**, according to certain aspects of the present disclosure. FIG. 16B is a top view of the second holder **2-310**, the second coil **2-512**, and the second sensing component **2-730**, according to certain aspects of the present disclosure.

(139) The second coils **2-512** correspond to the second magnetic components **2-511** (FIG. 12) provided on the frame **2-120** to drive the second holder **2-310** to move in the second dimension. As shown in FIGS. 16A to 16B, four second coils **2-512** are wound on the second holder **2-310**, and two sensing magnets **2-730** are disposed on two opposite-facing surfaces of the second holder **2-310**.

(140) FIG. 17A shows a perspective view of the first driving assembly **2-500**, the second driving

assembly **2-510**, and the third driving assembly **2-520** individually, according to certain aspects of the present disclosure. FIG. **17B** shows a top view of the first driving assembly **2-500**, the second driving assembly **2-510**, and the third driving assembly **2-520** individually, according to certain aspects of the present disclosure.

(141) As shown in FIG. **17A**, for illustration purposes, the directions of the magnetic poles the first magnetic component **2-501** and the second magnetic component **2-511** are indicated on one of the first magnetic components **2-501**, and the direction of the magnetic poles of the third magnetic component **2-521** is indicated on one of the third magnetic components **2-521**.

(142) The first coil **2-502** has a first segment **2-5022** that is perpendicular to the arrangement direction of the magnetic poles of the first magnetic component **2-501**. The second coil **2-512** has a second segment **2-5122** that is perpendicular to the arrangement direction of the magnetic poles of the second magnetic component **2-511**. The third coil **2-522** has a third segment **2-5222** that is perpendicular to the arrangement direction of the magnetic poles of the third magnetic component **2-521**.

(143) As shown in FIG. **17A**, the extending direction of the first segment **2-5022** is parallel to the extending direction of the second segment **2-5122**. The extending direction of the third segment **2-5222** is not parallel to the extending direction of the first segment **2-5022**. The extending direction of the third segment **2-5222** is not perpendicular to the extending direction of the first segment **2-5022**.

(144) The extending direction of the third segment **2-5222** is not parallel to the second axis **2-D2** when viewed along the main axis **2-D1**. The extending direction of the third segment **2-5222** is perpendicular to the second axis **2-D2** when viewed along the main axis **2-D1**. The arrangement direction of the magnetic poles of the third magnetic component **2-521** is parallel to the second axis **2-D2** when viewed along the main axis **2-D1**.

(145) The first segment **2-5022** and the first magnetic component **2-501** are configured to generate a first driving force. The second segment **2-5122** and the second magnetic component **2-511** are configured to generate a second driving force. The third segment **2-5222** and the third magnetic component **2-521** are configured to generate a third driving force.

(146) The first driving force may drive the first holder **2-210** (FIG. **8**) to move in the first dimension relative to the frame **2-120** (FIG. **8**). The second driving force may drive the second holder **2-310** (FIG. **8**) to move in the second dimension relative to the frame **2-120** (FIG. **8**). The third driving force may drive the first holder **2-210** (FIG. **8**) to move in a third dimension relative to the frame **2-120** (FIG. **8**).

(147) In detail, as shown in FIG. **17B**, the first axis **2-S1** located on the plane formed by the second axis **2-D2** and the third axis **2-D3**. Both the included angle between the first axis **2-S1** and the second axis **2-D2** and the included angle between the first axis **2-S1** and the third axis **2-D3** are 45 degrees. An axis **2-S2** is located on the plane formed by the second axis **2-D2** and the third axis **2-D3**, and the axis **2-S2** is perpendicular to the first axis **2-S1**.

(148) The first dimension is movement in the plane formed by the first axis **2-S1** and the second axis **2-D2** (which is also the plane formed by the second axis **2-D2** and the third axis **2-D3**). More specifically, the first dimension is movement with the first axis **2-S1** or the axis **2-S2** as the moving direction. The second dimension is movement along the second optical axis **2-O2** (FIG. **8**). The third dimension is the rotation around a rotational axis, and the rotational axis is parallel to the first optical axis **2-O1** (FIG. **8**).

(149) FIG. **18A** is a cross-sectional view of the first optical component **2-1**, the base **2-130**, the first holder **2-210**, the first circuit assembly **2-220**, the third circuit assembly **2-230**, the fourth circuit assembly **2-240**, the connecting portion **2-400**, and the magnetically permeable component **2-900**. From FIG. **18A**, a section of the magnetically permeable component **2-900** embedded in the first holder **2-210** can be seen.

(150) FIG. **18B** is a cross-sectional view taken along the dashed line **2-A** to **2-A'** in FIG. **18A**,

according to certain aspects of the present disclosure. From FIG. 18B, three magnetically permeable components 2-900 embedded in the first holder 2-210 and not exposed on the first holder 2-210 can be seen. FIG. 18C shows a top view of the first driving assembly 2-500, the second driving assembly 2-510, the third driving assembly 2-520, and the magnetically permeable component 2-900 individually.

(151) Referring to FIGS. 18A to 18C together, the magnetically permeable components 2-900 is made of a metal material. The magnetically permeable components 2-900 correspond to the first magnetic components 2-501. When viewed along the main axis 2-D1, there are two magnetically permeable components 2-900 located adjacent to the first sides 2-121 of the frame 2-120 (FIG. 11C), and another magnetically permeable component 2-900 is located adjacent to the second side 2-142 of the frame 2-120.

(152) The magnetically permeable component 2-900 at least partially overlaps the first driving assembly 2-500 when viewed along the main axis 2-D1. The magnetically permeable component 2-900 at least partially overlaps the second driving assembly 2-510 when viewed along the main axis 2-D1. The magnetically permeable component 2-900 at least partially overlaps the third driving assembly 2-520 when viewed along the main axis 2-D1.

(153) FIG. 19 is an exploded view of an optical component driving mechanism 2-10' according to another embodiment of the present disclosure. The difference between the optical component driving mechanism 2-10' shown in FIG. 19 and the optical component driving mechanism 2-10 shown in FIG. 8 is the housing 2-110', the frame 2-120', the base, and the first support assembly 2-600'.

(154) In the embodiment shown in FIG. 19, the appearance of the housing 2-110' and the frame 2-120' of the optical component driving mechanism 2-10' is different from that of the housing 2-110 and the frame 2-120 of the optical component driving mechanism 2-10. However, the housing 2-110' and the frame 2-120' have a similar arrangement relationship with the housing 2-110 and the frame 2-120. Furthermore, the optical component driving mechanism 2-10' has no base.

(155) In addition, in the embodiment shown in FIG. 1, the support components 2-601 are balls. In the embodiment shown in FIG. 19, the support components 2-601' are suspension wires. The first holder 2-210 is movable relative to the frame 2-120' via the support components 2-601'.

(156) FIG. 20A shows a perspective view of the optical component driving mechanism 2-10' of FIG. 19, but the housing 2-110' is not shown for illustration purposes. FIG. 20B shows a perspective view of the optical component driving mechanism 2-10' of FIG. 19, but the housing 2-110' is not shown for illustration purposes.

(157) As shown in FIGS. 20A to 20B, two ends of the support component 2-601' are connected to the first elastic member 2-651 and the first holder 2-210, respectively. The support component 2-601' may support the first holder 2-210 to move relative to the frame 2-120'.

(158) In summary, the present invention provides an optical component driving mechanism for driving the first optical component and the second optical component, thereby achieving functions such as optical focusing or optical shake compensation. The first optical component is driven by the first driving assembly to move in a plane perpendicular to the first optical axis. The second optical component is driven by the second driving assembly to move along the second optical axis. The first optical component is driven by the third driving assembly to rotate around the first optical axis. The combination of the three driving mechanisms enables the optical component driving mechanism to have better optical focusing and optical compensation capabilities, which greatly improving the performance of electronic devices.

(159) The third embodiment of the present disclosure is described below.

(160) Refer to FIG. 21A. FIG. 21A is a schematic view of an optical module 3-1001 in some embodiments of the present disclosure. The optical module 3-1001 may mainly include a light amount adjusting mechanism 3-1100 and an optical element driving mechanism 3-1200. An optical element 3-1230 may be disposed in the optical element driving mechanism 3-1200, and the optical

element driving mechanism **3-1200** may drive the optical element **3-1230** to achieve optical image stabilization (OIS) or auto focus (AF). The light amount adjusting mechanism **3-1100** may be disposed on the optical element driving mechanism **3-1200** to control the amount or characteristic of light incident to the optical element **3-1230**. For example, the light amount adjusting mechanism **3-1100** may be an aperture to control the depth of field, imaging quality, and amount of light coming in.

(161) In some embodiments, the optical element **3-1230** may include a lens, a mirror, a prism, a beam splitter, an aperture, a liquid lens, an image sensor, a camera module, or a ranging module. It should be noted that the definition of the optical element is not limited to the element that is related to visible light, and other elements that relate to invisible light (e.g. infrared or ultraviolet) are also included in the present disclosure. For example, when the optical element **3-1230** is a camera lens, the optical element **3-1230** may include a lens barrel **3-1231** and at least one lens **3-1232**. In some embodiments, the lens barrel **3-1231** may include nonmetal material, and the heat conductivity of the lens barrel **3-1231** may be different from the heat conductivity of the holder **3-1220**, such as the heat conductivity of the lens barrel **3-1231** may be higher than the heat conductivity of the holder **3-1220**.

(162) FIG. 22A is a schematic view of the light amount adjusting mechanism **3-1100**. FIG. 22B is an exploded view of the light amount adjusting mechanism **3-1100**. As shown in FIG. 21A, FIG. 22A, and FIG. 22B, the light amount adjusting mechanism **3-1100** may mainly include a case **3-1111**, a bottom **3-1112**, a top plate **3-1113**, a movable portion **3-1120**, a light amount control element **3-1140**, a first driving assembly **3-1150**, a third resilient element **3-1160**, a connecting element **3-1162**, a magnetic conductive element **3-1164**, and a position sensor **3-1166** arranged in a main axis **3-1500**. The case **3-1111**, the bottom **3-1112**, and the top plate **3-1113** may be called as a fixed portion **3-1110**. The light amount control element **3-1140** may include a first light amount control unit **3-1141**, a second light amount control unit **3-1142**, a third light amount control unit **3-1143**, and a fourth light amount control unit **3-1144**, or may include other optical control elements such as blades, polarizer, or filter. The case **3-1111** and the bottom **3-1112** form an accommodating space **3-1130** used for accommodating the movable portion **3-1120**, the third resilient element **3-1160**, the connecting element **3-1162**, the magnetic conductive element **3-1164**, and the position sensor **3-1166**, etc. In some embodiments, the distance between the bottom **3-1112** and the optical element **3-1230** is less than the distance between the case **3-1111** and the optical element **3-1230**. The light amount control element **3-1140** may be outside the accommodating space **3-1130**.

(163) The movable portion **3-1120** may be used for connecting to the light amount control element **3-1140** and may move relative to the fixed portion **3-1110**, such as may be movably connected to the bottom **3-1112** through the connecting element **3-1162**. The first driving assembly **3-1150** may drive the movable portion **3-1120** to move relative to the fixed portion **3-1110**. For example, the first driving assembly **3-1150** may include a first driving element **3-1151** and a second driving element **3-1152** disposed on the movable portion **3-1120** and the fixed portion **3-1110** (e.g. the bottom **3-1112**), respectively. The first driving element **3-1151** and the second driving element **3-1152** may be a combination of a magnet and a coil used for generating a driving force to drive the movable portion **3-1120** moving relative to the fixed portion **3-1110**. In some embodiments, the first driving assembly **3-1150** may include other driving elements, such as piezoelectric element or shape memory alloy. The magnetic conductive element **3-1164** may be used for guiding the magnetic field direction of the first driving element **3-1151**. In some embodiments, as shown in FIG. 21A and FIG. 22B, the first driving element **3-1151** and the second driving element **3-1152** may arrange along the main axis **3-1500**, and the magnetic conductive element **3-1164** and the first driving element **3-1151** may arrange along the main axis **3-1500**.

(164) The position sensor **3-1166** may be used for detecting the magnetic field variation of the first driving element **3-1151** when the first driving element **3-1151** is moving to get the position of the movable portion **3-1120** relative to the fixed portion **3-1110**. For example, the position sensor **3-**

1166 may include a Hall sensor, a magnetoresistance effect sensor (MR sensor), a giant magnetoresistance effect sensor (GMR sensor), a tunneling magnetoresistance effect sensor (TMR sensor), or a fluxgate sensor.

(165) In some embodiments, the optical element driving mechanism **3-1200** may mainly include a shell **3-1211**, a base **3-1212**, a holder **3-1220**, and a second driving assembly **3-1240**. The shell **3-1211** and the base **3-1212** may be affixed with each other to form a shell of the optical element driving mechanism **3-1200** for accommodating other elements. The holder **3-1220** may move relative to the shell **3-1211** and the base **3-1212** and may be used for connecting to the optical element **3-1230**.

(166) The second driving assembly **3-1240** may include a third driving element **3-1241** and a fourth driving element **3-1242** disposed on the holder **3-1220** and the shell **3-1211**. The third driving element **3-1241** and the fourth driving element **3-1242** may be a combination of a magnet and a coil used for generating a driving force to drive the holder **3-1220** moving relative to the shell **3-1211**. In some embodiments, the second driving assembly **3-1240** may include other driving elements, such as piezoelectric element or shape memory alloy.

(167) In some embodiments, the holder **3-1220** may be suspended in the second accommodating space **3-1260** formed from the shell **3-1211** and the base **3-1212** by a first resilient element **3-1251** and a second resilient element **3-1252**. Therefore, the holder **3-1220** may be movably connected to the shell **3-1211** through the first resilient element **3-1251** and the second resilient element **3-1252**.

(168) In some embodiments, when the first driving assembly **3-1150** drives the movable portion **3-1120** to move relative to the fixed portion **3-1110**, the first driving assembly **3-1150** may generate heat. However, excess heat may affect the imaging quality of the optical element **3-1230**. Therefore, a heat control assembly **3-1300** may be disposed in the optical module **3-1001** to adjust the temperature of the optical element **3-1230**, so the image quality may be enhanced. In some embodiments, the heat control assembly **3-1300** may correspond to the holder **3-1220** or the optical element **3-1230**, and may include a first heat control element **3-1311**, and a second heat control element **3-1320**.

(169) FIG. **21B** is a schematic view of some elements in FIG. **21A**. For example, the first heat control element **3-1311** may isolate heat, and may be disposed between the light amount adjusting mechanism **3-1100** and the optical element driving mechanism **3-1200**, such as between the optical element **3-1230** and the light amount adjusting mechanism **3-1100** to prevent the heat generated from the first driving assembly **3-1150** (heat source) to the optical element **3-1230**.

(170) The second heat control element **3-1320** may perform heat conduction or heat dissipation, so the heat generated by the first driving assembly **3-1150** (heat source) may be taken away from the optical element **3-1230**. In some embodiments, the second heat control element **3-1320** may include metal, and the bottom **3-1112** does not include metal, such as the bottom **3-1112** may include nonmetal materials (e.g. plastic or resin, etc.). For example, the second heat control element **3-1320** may be affixed on the fixed portion **3-1110**, such as may be embedded in the bottom **3-1112**, may expose from a first surface **3-1116** of the bottom **3-1112** facing away from the optical element **3-1230**, and does not expose from a second surface **3-1117** of the bottom **3-1112** facing the optical element **3-1230**. In some embodiments, the second heat control element **3-1320** may connect to the case **3-1111**, and the material of the case **3-1111** may include metal, so the heat generated from the first driving assembly **3-1150** may be transferred from the case **3-1111** by the second heat control element **3-1320**. Afterwards, the heat may be dissipated by the metal case **3-1111**. Moreover, in some embodiments, since the second heat control element **3-1320** is exposed from the bottom **3-1112**, the heat may be further dissipated from the portion of the second heat control element **3-1320** exposed from the bottom **3-1112**. Therefore, the optical element **3-1230** may be prevented from being affected by the heat generated by the first driving assembly **3-1150**.

(171) In some embodiments, the heat conductivity of the first heat control element **3-1311** is less than the heat conductivity of the second heat control element **3-1320**. The heat conductivity of the

bottom **3-1112** is less than the heat conductivity of the case **3-1111**. The heat conductivity of the second heat control element **3-1320** is higher than the heat conductivity of the case **3-1111**. In some embodiments, the distance between the first heat control element **3-1311** and the optical element **3-1230** is less than the distance between the second heat control element **3-1320** and the optical element **3-1230**. The first heat control element **3-1311** is disposed between the optical element **3-1230** and the second heat control element **3-1320**.

(172) In some embodiments, the first adhesive element **3-1400** may connect the holder **3-1220** and the optical element **3-1230**. For example, as shown in FIG. 21A and FIG. 21B, the first adhesive element **3-1400** may be in direct contact with the holder **3-1220** and the optical element **3-1230**, and the first adhesive element **3-1400** may include nonmetal material (e.g. plastic or resin). In some embodiments, the first heat control element **3-1311** may be called as a second adhesive element, and the second heat control element **3-1320** may be (indirectly) connected to the optical element **3-1230** through the first heat control element **3-1311**. In some embodiments, the material of the first heat control element **3-1311** and the first adhesive element **3-1400** may be different, such the heat conductivity of the first heat control element **3-1311** may be less than the heat conductivity of the first adhesive element **3-1400**.

(173) FIG. 21C is a schematic view of an optical module **3-1002** in some embodiments of the present disclosure. FIG. 21D is a schematic view of some elements in FIG. 21C. In some embodiments, the elements of the optical module **3-1002** may be substantially similar to the elements of the optical module **3-1001**, and the difference is that a first heat control element **3-1312** of the optical module **3-1002** may be a gap positioned between the bottom **3-1112** and the optical element **3-1230** to prevent heat conduction. In such embodiment, a third adhesive element **3-1313** may be used for connecting the bottom **3-1112** and the holder **3-1220**. The third adhesive element **3-1313** may be glue or solder material, and the heat conductivity of the third adhesive element **3-1313** may be different from the heat conductivity of the first adhesive element **3-1400**. This configuration also prevents the heat generated from the first driving assembly **3-1150** (heat source) to reach the optical element **3-1230**.

(174) FIG. 23A is a schematic view of some elements of the light amount adjusting mechanism **3-1100**. FIG. 23B is a top view of some elements of the light amount adjusting mechanism **3-1100**, wherein the top plate **3-1113** is omitted. FIG. 23C is a top view of some elements of the light amount adjusting mechanism **3-1100**, wherein the elements on the case **3-1111** is omitted. FIG. 23D is a top view of some elements of the light amount adjusting mechanism **3-1100**, wherein the case **3-1111** and the elements on the case **3-1111** are omitted.

(175) As shown in FIG. 23A to FIG. 23D, the first light amount control unit **3-1141**, the second light amount control unit **3-1142**, the third light amount control unit **3-1143**, and the fourth light amount control unit **3-1144** of the light amount control element **3-1140** may form an opening with a size **3-D1**. The opening may be used for allowing light passing through. Moreover, the first light amount control unit **3-1141**, the second light amount control unit **3-1142**, the third light amount control unit **3-1143**, and the fourth light amount control unit **3-1144** may be movably connected to the movable portion **3-1120**.

(176) Specifically, in some embodiments, when viewed along the main axis **3-1500**, the first light amount control unit **3-1141** include a first guiding recess **3-1181** extending in a first direction (e.g. the Y direction). The second light amount control unit **3-1142** includes a second guiding recess **3-1182** extending in the first direction. The third light amount control unit **3-1143** includes a second guiding recess **3-1182** extending in a second direction (e.g. the X direction). The fourth light amount control unit **3-1144** may include a fourth guiding recess **3-1184** extending in the second direction.

(177) Furthermore, the movable portion **3-1120** may include a first guiding portion **3-1121**, a second guiding portion **3-1122**, a third guiding portion **3-1123**, and a fourth guiding portion **3-1124** extending in the main axis **3-1500**. The first guiding portion **3-1121** may be disposed in the first

guiding recess **3-1181**, the second guiding portion **3-1122** may be disposed in the second guiding recess **3-1182**, the third guiding portion **3-1123** may be disposed in the third guiding recess **3-1183**, and the fourth guiding portion **3-1124** may be disposed in the fourth guiding recess **3-1184**.

(178) In some embodiments, when the movable portion **3-1120** rotates, the first guiding portion **3-1121**, the second guiding portion **3-1122**, the third guiding portion **3-1123**, and the fourth guiding portion **3-1124** may slide in the first guiding recess **3-1181**, the second guiding recess **3-1182**, the third guiding recess **3-1183**, and the fourth guiding recess **3-1184**, respectively, to move the first light amount control unit **3-1141**, the second light amount control unit **3-1142**, the third light amount control unit **3-1143**, and the fourth light amount control unit **3-1144** in specific directions. Therefore, the size of the opening may be controlled to adjust the size of the aperture.

(179) In some embodiments, the first light amount control unit **3-1141** may further include a first positioning recess **3-1191** and a second positioning recess **3-1192** extending in the second direction (the X direction). The second light amount control unit **3-1142** may further include a third positioning recess **3-1193** and a fourth positioning recess **3-1194** extending in the second direction. The third light amount control unit **3-1143** may further include a fifth positioning recess **3-1195** extending in the first direction (the Y direction). The fourth light amount control unit **3-1144** may further include a sixth positioning recess **3-1196** extending in the first direction.

(180) In some embodiments, the case **3-1111** may include a first positioning portion **3-1171**, a second positioning portion **3-1172**, a third positioning portion **3-1173**, a fourth positioning portion **3-1174**, a fifth positioning portion **3-1175**, a sixth positioning portion **3-1176**, a seventh positioning portion **3-1177**, and an eighth positioning portion **3-1178** extending along the main axis **3-1500**. The first positioning portion **3-1171** may be disposed in the first positioning recess **3-1191**. The second positioning portion **3-1172** may be disposed in the second positioning recess **3-1192**. The third positioning portion **3-1173** may be disposed in the third positioning recess **3-1193**. The fourth positioning portion **3-1174** may be disposed in the fourth positioning recess **3-1194**. The fifth positioning portion **3-1175** and the sixth positioning portion **3-1176** may be disposed in the fifth positioning recess **3-1195**. The seventh positioning portion **3-1177** and the eighth positioning portion **3-1178** may be disposed in the sixth positioning recess **3-1196**. The first positioning portion **3-1171** and the second positioning portion **3-1172** may arrange in the second direction. The third positioning portion **3-1173** and the fourth positioning portion **3-1174** may arrange in the second direction. The fifth positioning portion **3-1175** and the sixth positioning portion **3-1176** may arrange in the first direction. The seventh positioning portion **3-1177** and the eighth positioning portion **3-1178** may arrange in the first direction.

(181) Therefore, the movable directions of the first light amount control unit **3-1141**, the second light amount control unit **3-1142**, the third light amount control unit **3-1143**, and the fourth light amount control unit **3-1144** may be controlled by the positioning portions arranged in specific directions. For example, since the first positioning portion **3-1171** and the second positioning portion **3-1172** arrange in the second direction, the movable direction of the first light amount control unit **3-1141** is restricted in the second direction. Moreover, the movable range of the first light amount control unit **3-1141**, the second light amount control unit **3-1142**, the third light amount control unit **3-1143**, and the fourth light amount control unit **3-1144** may be defined by the first positioning portion **3-1171**, the second positioning portion **3-1172**, the third positioning portion **3-1173**, the fourth positioning portion **3-1174**, the fifth positioning portion **3-1175**, the sixth positioning portion **3-1176**, the seventh positioning portion **3-1177**, and the eighth positioning portion **3-1178**.

(182) As shown in FIG. 23D, the third resilient element **3-1160** may be disposed on the bottom **3-1112**, the movable portion **3-1120** may include a recess **3-1125**, and the third resilient element **3-1160** may be disposed in the recess **3-1125**. The size of the recess **3-1125** may be greater than the size of the third resilient element **3-1160**. Therefore, the movable range of the movable portion **3-1120** may be defined by the third resilient element **3-1160** when the movable portion **3-1120** rotates

in the clockwise direction or in the counterclockwise direction.

(183) FIG. 24A to FIG. 24C are schematic views of some elements of the light amount adjusting mechanism 3-1100 when the movable portion 3-1120 rotates in the clockwise direction (first dimension), wherein similar elements in FIG. 23A to FIG. 23C are shown. As shown in FIG. 24A to FIG. 24C, when the movable portion 3-1120 rotates in the clockwise direction until the first guiding portion 3-1121 being in contact with a first stopping portion 3-1114 of the case 3-1111, the opening defined by the first light amount control unit 3-1141, second light amount control unit 3-1142, third light amount control unit 3-1143, fourth light amount control unit 3-1144 has a size 3-D2, wherein the size 3-D2 is greater than the size 3-D1. Therefore, the size of the opening may be adjusted.

(184) FIG. 25A to FIG. 25C are schematic views of some elements of the light amount adjusting mechanism 3-1100 when the movable portion 3-1120 rotates in the counterclockwise direction (second dimension), wherein similar elements in FIG. 23A to FIG. 23C are shown. As shown in FIG. 25A to FIG. 25C, when the movable portion 3-1120 rotates in the clockwise direction until the first guiding portion 3-1121 being in contact with a second stopping portion 3-1115 of the case 3-1111, the opening defined by the first light amount control unit 3-1141, second light amount control unit 3-1142, third light amount control unit 3-1143, fourth light amount control unit 3-1144 has a size 3-D3, wherein the size 3-D3 is less than the size 3-D1 and the size 3-D2. Therefore, the size of the opening may be adjusted.

(185) FIG. 26 is a schematic view of a light amount adjusting mechanism 3-2100 in some embodiments of the present disclosure. In some embodiments, the light amount adjusting mechanism 3-2100 may mainly include a case 3-2111, a bottom 3-2112, a top plate 3-2113, a movable portion 3-2120, a light amount control element 3-2140, a first driving element 3-2151, a first driving element 3-2152, a connecting element 3-2162, and a magnetic conductive element 3-2164 arranged in a main axis 3-2500. The light amount adjusting mechanism 3-2100 may substitute the light amount adjusting mechanism 3-1100 to be disposed in the optical module 3-1001 or the optical module 3-1002 to control the amount or characteristic of light incident to the optical element 3-1230. The case 3-2111, the bottom 3-2112, the top plate 3-2113 may form an accommodating space 3-2300 to accommodating other elements. The functions of the case 3-2111, the bottom 3-2112, the top plate 3-2113, the movable portion 3-2120, the light amount control element 3-2140, the first driving element 3-2151, the first driving element 3-2152, the connecting element 3-2162, the magnetic conductive element 3-2164 may be identical or similar to the case 3-1111, the bottom 3-1112, the top plate 3-1113, the movable portion 3-1120, the light amount control element 3-1140, the first driving element 3-1151, the second driving element 3-1152, the connecting element 3-1162, and the magnetic conductive element 3-1164, and are not described again.

(186) As shown in FIG. 26, in some embodiments, the first driving element 3-2151 and the first driving element 3-2152 may arrange in a direction that is perpendicular to the main axis 3-2500, and the magnetic conductive element 3-2164 and the first driving element 3-2151 are also arranged in the direction that is perpendicular to the main axis 3-2500. The first driving element 3-2152 may be between the magnetic conductive element 3-2164 and the first driving element 3-2151. Therefore, the movable portion 3-2120 may be driven to move relative to the case 3-2111 or the bottom 3-2112 to control the light amount control element 3-2140, so the amount or characteristic of the light incident to the optical element 3-1230 may be controlled.

(187) An optical module is provided in some embodiments of the present disclosure. The optical module includes a holder for connecting to an optical element and a heat control assembly used for control the temperature of the optical element. The heat control assembly corresponds to the optical element or the holder. Therefore, the heat generated from elements other may be prevented from affecting the optical element, and miniaturization may be achieved.

(188) The relative positions and size relationship of the elements in the present disclosure may

allow the driving mechanism achieving miniaturization in specific directions or for the entire mechanism. Moreover, different optical modules may be combined with the driving mechanism to further enhance optical quality, such as the quality of photographing or accuracy of depth detection. Therefore, the optical modules may be further utilized to achieve multiple anti-vibration systems, so image stabilization may be significantly improved.

(189) The fourth embodiment of the present disclosure is described below.

(190) An optical element driving mechanism is provided in the present disclosure, including a plurality of optical elements, such as lenses and optical sensing elements, etc. To achieve desirable optical effects, these optical elements may be movable relative to each other. Therefore, the optical element driving mechanism of the present disclosure further includes a plurality of driving assemblies for moving one or more optical elements, respectively. In the present disclosure, these driving assemblies allow the optical elements to move in different directions, such as translational movements on X, Y, Z axes and/or rotational movements around Z axis, thereby achieving great optical effects.

(191) Referring to FIG. 27, FIG. 27 is an exploded view of the optical element driving mechanism **4-10**, according to some embodiments of the present disclosure. As shown in FIG. 27, the optical element driving mechanism **4-10** mainly includes: a first movable portion **4-100**, a second movable portion **4-200**, a third movable portion **4-300**, a first driving assembly **4-400**, a second driving assembly **4-500**, a third driving assembly **4-600**, and a fixed portion **4-900**. In some embodiments, the first movable portion **4-100** may be connected to a first optical element (e.g. a lens group including one or more lenses, not shown), and the second movable portion **4-200** may also be connected to the first optical element. The third movable portion **4-300** may be connected to a second optical element (e.g. an optical sensing element, not shown). Each of the components of the optical element driving mechanism **4-10** are arranged along the main axis **4-M**. The first optical element has a first optical axis **4-O1**, and the second optical element has a second optical axis **4-O2** (see FIG. 30). In some embodiments, the main axis **4-M**, the first optical axis **4-O1**, and the second optical axis **4-O2** are parallel to one another. According to some embodiments of the present disclosure, the first driving assembly **4-400** drives the first movable portion **4-100** to move relative to the fixed portion **4-900** in a first dimension. The second driving assembly **4-500** drives the second movable portion **4-200** to move relative to the fixed portion **4-900** in a second dimension. The third driving assembly **4-600** drives the third movable portion **4-300** to move relative to the fixed portion **4-900** in a third dimension. More specifically, the second movable portion **4-200** is movable relative to the first movable portion **4-100**, and the third movable portion **4-300** is movable relative to the first movable portion **4-100** and the second movable portion **4-200**. In some embodiments, the third dimension is different from the first dimension, and also different from the second dimension. For example, in some embodiments, a movement in the first dimension is a translational movement along the main axis **4-M**. A movement in the second dimension is a translational movement along the first optical axis **4-O1**. A movement in the third dimension is a translational movement in a direction that is perpendicular to the second optical axis **4-O2** or a rotational movement around a first rotational axis, wherein the first rotational axis is parallel to the second optical axis **4-O2**.

(192) Referring to FIG. 27 and FIG. 28, FIG. 28 is a perspective view of the optical element driving mechanism **4-10**, according to some embodiments of the present disclosure. The optical element driving mechanism **4-10** of the present disclosure further includes a first supporting assembly **4-710**, a second supporting assembly **4-720**, and a third supporting assembly **4-730**. The first supporting assembly **4-710** is disposed between the first movable portion **4-100** and the fixed portion **4-900**. The first movable portion **4-100** moves relative to the fixed portion **4-900** via the first supporting assembly **4-710**. The second supporting assembly **4-720** is disposed between the first movable portion **4-100** and the second movable portion **4-200**. The second movable portion **4-200** moves relative to the fixed portion **4-900** via the second supporting assembly **4-720**. The third

supporting assembly **4-730** is disposed between the first movable portion **4-100** and the third movable portion **4-300**. The third movable portion **4-300** moves relative to the fixed portion **4-900** via the third supporting assembly **4-730**.

(193) Specifically, the first supporting assembly **4-710** includes a first supporting element with a bar-shaped structure that is fixedly disposed at the fixed portion **4-900** and extends along the main axis, as shown in FIG. 28. The first movable portion **4-100** has a through hole that corresponds to the first supporting element, allowing the first supporting element to go through the through hole, so that the first movable portion **4-100** is movable relative to the first supporting element. The second supporting assembly **4-720** includes one or more second elements that have flexibility and plate structures and are perpendicular to the first optical axis **4-O1**. In the embodiment shown in FIG. 28, the second supporting assembly **4-720** includes two supporting elements, disposed above and under the second movable portion **4-200**, respectively. In some embodiments, the second supporting elements may be spring sheets or other suitable flexible material, and may be in any suitable shapes. The second movable portion **4-200** is movably connected to the first movable portion **4-100** via the second supporting elements. The third supporting assembly **4-730** includes one or more third supporting elements that have flexibility and bar-shaped structures. In the embodiments shown in FIG. 28, the third supporting assembly **4-730** includes four of the third supporting elements, disposed at the four corners of the first movable portion **4-100**, respectively, and extending along the second optical axis **4-O2**. In some embodiments, the third supporting elements may be suspension wires. The third movable portion **4-300** is movably connected to the first movable portion **4-100** via the third supporting element. In some other embodiments, the third supporting elements may have ball-shaped structures. By disposing multiple balls between the first movable portion **4-100** and the third movable portion **4-300**, the third movable portion **4-300** is movable relative to the first movable portion **4-100**. It should be noted that neither the second supporting assembly **4-720** nor the third supporting assembly **4-730** is in contact with the fixed portion **4-900**. Additionally, if the side of the fixed portion **4-900** without the first supporting assembly **4-710** is referred to as the first side **4-901** (see FIG. 31), and the side of the fixed portion **4-900** with the first supporting assembly **4-710** is referred to as the second side **4-902** (see FIG. 31), as shown in FIG. 28, the distance between the second supporting assembly **4-720** and the first side **4-901** of the fixed portion **4-900** is smaller than the distance between the second supporting assembly **4-720** and the second side **4-902** of the fixed portion **4-900**.

(194) As shown in FIG. 28, on the side opposite from the first supporting assembly **4-710**, the first driving assembly **4-400** is disposed. The first driving assembly **4-400** includes a driving element **4-410**, a transmitting element **4-420**, and a conducting element **4-430**. The driving element **4-410** is affixed to the fixed portion **4-900**, having piezoelectric material and generating the first driving force **4-F1** (see FIG. 30). The direction of the first driving force **4-F1** is parallel to the main axis **4-M**. The transmitting element **4-420** has a bar-shaped structure and extends along the main axis **4-M**. One of the ends of the transmitting element **4-420** is connected to the driving element **4-410**, transmitting the first driving force **4-F1** to the first movable portion **4-100**. The transmitting element **4-420** is movable relative to the fixed portion **4-900** and the first movable portion **4-100**, achieving effects of optical zooming or optical focusing. More specifically, the first movable portion **4-100** has a through hole that corresponds to the transmitting element **4-420**, allowing the transmitting element **4-420** to go through the through hole, so that the first movable portion **4-100** is movable relative to the transmitting element **4-420**. When the transmitting element **4-420** is pushed by the first driving force **4-F1** generated by the driving element **4-410** and moves along the main axis **4-M**, if the friction force between the transmitting element **4-420** and the first movable portion **4-100** is smaller than the maximum static friction therebetween, the transmitting element **4-420** may carry the first movable portion **4-100** to move together along the main axis **4-M**. Thus, the first movable portion **4-100** may be driven to move relative to the fixed portion **4-900**. It should be noted that, in some embodiments, the first driving assembly **4-400** drives the first movable portion

4-100 to move while carrying the second movable portion **4-200** to move relative to the fixed portion **4-900**. In some embodiments, the first driving assembly **4-400** drives the first movable portion **4-100** to move while also carrying the third movable portion **4-300** to move relative to the fixed portion **4-900**. The conducting element **4-430** is electrically connected to the driving element **4-410** and an external power source, providing a driving signal to the first driving assembly **4-400**. (195) Next, referring to FIG. 29 and FIG. 30, FIG. 29 and FIG. 30 are respectively a top view and a front view of the optical element driving mechanism **4-10**, according to some embodiments of the present disclosure, wherein the case **4-910** and the first movable portion **4-100** are omitted. In some embodiments, the second movable portion **4-200** includes a first holder **4-210**. The first holder **4-210** may be connected to the first optical element (not shown). For example, the first optical element may be disposed inside the first holder **4-210**. The third movable portion **4-300** includes a second holder **4-310**, a circuit assembly **4-330** and a bottom board **4-350**. The second holder **4-310** may be connected to the second optical element (not shown). For example, the second optical element may be disposed inside the second holder **4-310**. The circuit assembly **4-330** is electrically connected to the third driving assembly **4-600**, providing driving force to the third movable portion **4-300**. The bottom board **4-350** is fixedly connected to the second holder **4-310**. There are holes on the bottom board **4-350** for the first driving assembly **4-400** and the first supporting assembly **4-710** to go through.

(196) As shown in FIG. 29, the second driving assembly **4-500** includes a first coil **4-510** and at least one first magnetic elements **4-520**. In the embodiment of FIG. 29, the first coil **4-510** has a ring structure surrounding the second movable portion **4-200**, which is helpful for simplifying the circuit routes. In some other embodiments, the first coil **4-510** may also be multiple coils that are disposed on each side of the second movable portion **4-200**. In the embodiment of FIG. 29, the second driving assembly **4-500** includes four of the first magnetic elements **4-520**, disposed on four sides of the second movable portion **4-200**, respectively. The first magnetic elements **4-520** correspond to the first coil **4-510**, generating the second driving force **4-F2** (FIG. 30). The direction of the second driving force **4-F2** is parallel to the first optical axis **4-O1**. The second driving force **4-F2** drives the second movable portion **4-200** to move along the first optical axis **4-O1** relative to the fixed portion **4-900**.

(197) As shown in FIG. 29 and FIG. 30, the third driving assembly **4-600** includes three of the second coils **4-610** and three of the second magnetic elements **4-620**. Each of the second magnetic elements **4-620** corresponds to one of the second coils **4-610**, generating the third driving force **4-F3**. Due to the positions of the second coils **4-610** and the second magnetic elements **4-620**, the third driving force **4-F3** may be generated in X direction and in Y direction, so that the third driving assembly **4-600** may drive the third movable portion **4-300** to move in X direction and in Y direction, that is, in directions that are perpendicular to the second optical axis **4-O2**. When viewed along the second optical axis **4-O2**, any one of the third driving forces **4-F3** extends through the center of the second optical element, as shown in FIG. 29. Additionally, since the second coils **4-610** and the second magnetic elements **4-620** are all disposed above the second optical element (in the +Z direction), the third driving forces **4-F3** do not extend through the center of the second optical element when viewed in a direction that is perpendicular to the second optical axis **4-O2** (as the view angle in FIG. 30). The third driving assembly **4-600** further includes a third coil **4-660** and a third magnetic element **4-670**. The third magnetic element **4-670** corresponds to the third coil **4-660**, generating the fourth driving force **4-F4**. As shown in FIG. 29, the direction of the fourth driving force **4-F4** is perpendicular to the second optical axis **4-O2**, being a driving force that rotates around the second optical axis **4-O2**. Therefore, the third driving assembly **4-600** may also drive the third movable portion **4-300** to rotate around the second optical axis **4-O2**.

(198) It should be noted that, for miniaturization of the mechanism, in some embodiments, the second magnetic elements **4-620** may be formed integrally with the first magnetic elements **4-520**, and the third magnetic element **4-670** may also be formed integrally with one of the first magnetic

elements **4-520**. In other words, the second driving assembly **4-500** and the third driving assembly **4-600** may share the magnetic elements. Additionally, when viewed along the second optical axis **4-O2**, the second magnetic elements **4-620** may have bar-shaped structures, such as rectangular structures. In FIG. **29**, the two of the second magnetic elements **4-620** that are arranged in Y direction extend along the first axis **4-A1**, and the second magnetic element **4-620** and the third magnetic element **4-670** that are arranged in X direction extend along the second axis **4-A2**. The first axis **4-A1** and the second axis **4-A2** are not parallel. In some embodiments, the first axis **4-A1** is perpendicular to the second axis **4-A2**. In the embodiment shown in FIG. **29**, the third magnetic element **4-670** has an arc structure when viewed along the second optical axis **4-O2**. The arc structure of the third magnetic element **4-670** is helpful for the stability of the fourth driving force **4-F4** which provides a rotational motion. As shown in FIG. **29**, when viewed along the second optical axis **4-O2**, the largest size of the second magnetic element **4-620** along the first axis **4-A1** is different from the largest size of the third magnetic element **4-670** along the second axis **4-A2**. More specifically, the largest size of the second magnetic element **4-620** along the first axis **4-A1** is larger than the largest size of the third magnetic element **4-670** along the second axis **4-A2**. Correspondingly, the largest size of the second coil **4-610** along the first axis **4-A1** is different from the largest size of the third coil **4-660** along the second axis **4-A2**. More specifically, the largest size of the second coil **4-610** along the first axis **4-A1** is larger than the largest size of the third coil **4-660** along the second axis **4-A2**. Additionally, in some embodiments, the second coil **4-610** and the third coil **4-660** may be at least partially embedded in the circuit assembly **4-330**.

(199) Next, referring to FIG. **31**, FIG. **31** is a top view of the optical element driving mechanism **4-10**, according to some embodiments of the present disclosure, wherein the case **4-910** is omitted. When viewed along the main axis **4-M**, the fixed portion **4-900** has a polygonal structure, such as a rectangular structure. As mentioned above, the fixed portion **4-900** includes the first side **4-901** and the second side **4-902**. The first side **4-901** extends along a third axis **4-A3**, and the second side **4-902** extends along a fourth axis **4-A4**. The largest size of the first side **4-901** on the third axis **4-A3** is different from the largest size of the second side **4-902** on the fourth axis **4-A4**. More specifically, The largest size of the first side **4-901** on the third axis **4-A3** is larger than the largest size of the second side **4-902** on the fourth axis **4-A4**. It should be noted that, in the embodiments of the present disclosure, the first axis **4-A1** is parallel to the third axis **4-A3**, and the second axis **4-A2** is parallel to the fourth axis **4-A4**.

(200) When viewed along the main axis **4-M**, the first driving assembly **4-400** is located at the second side **4-902** of the fixed portion **4-900**. As a result, the overall size of the mechanism may be reduced in a certain direction (e.g. Y direction). When viewed along the third axis **4-A3**, the first driving assembly **4-400** partially overlaps the second driving assembly **4-500**. When viewed along the fourth axis **4-A4**, the first driving assembly **4-400** does not overlap the second driving assembly **4-500**, and the first driving assembly **4-400** does not overlap the third driving assembly **4-600** as well. When viewed along the third axis **4-A3**, the first driving assembly **4-400** partially overlaps the third driving assembly **4-600**. More specifically, when viewed along the third axis **4-A3**, the first driving assembly **4-400** partially overlaps the second magnetic element **4-620**, and the first driving assembly **4-400** also partially overlaps the third magnetic element **4-670**. Additionally, as shown in FIG. **31**, when viewed along the main axis **4-M**, a line connecting the first supporting assembly **4-710** and the first driving assembly **4-400** passes through the first optical element that is located in the center.

(201) Next, referring to FIG. **32**, FIG. **32** is a left side view of the optical element driving mechanism **4-10**, according to some embodiments of the present disclosure. When viewed along the third axis **4-A3**, the first supporting assembly **4-710** at least partially overlaps the first driving assembly **4-400**; the first supporting assembly **4-710** partially overlaps the second driving assembly **4-500**; the first supporting assembly **4-710** partially overlaps the third driving assembly **4-600**; the first supporting assembly **4-710** partially overlaps the first optical element; and the first supporting

assembly **4-710** partially overlaps the second optical element. Additionally, when viewed along the fourth axis **4-A4**, the first supporting assembly **4-710** does not overlap the first driving assembly **4-400**; the first supporting assembly **4-710** does not overlap the second driving assembly **4-500**; the first supporting assembly **4-710** does not overlap the third driving assembly **4-600**; the first supporting assembly **4-710** does not overlap the first optical element; and the first supporting assembly **4-710** does not overlap the second optical element.

(202) In some embodiments, the fixed portion **4-900** may include a case **4-910**, a base **4-920**, and a third optical element **4-950**. The case **4-910** includes a top wall that has a plate shape and is perpendicular to the main axis **4-M**. The base **4-920** is fixedly connected to the case **4-910**. An accommodating space **4-925** is formed between the case **4-910** and the base **4-920**, for accommodating the first movable portion **4-100** and other components. The third optical element **4-950** is fixedly disposed on the case **4-910**. In some embodiments, since the third optical element **4-950** is closer to the light source than the first optical element, the light passes through the third optical element **4-950** before entering the first optical element. In some embodiments, the third optical element **4-950** is for optical zooming. In some embodiments, the first driving assembly **4-400** may drive the first optical element to move relative to the third optical element **4-950**.

Additionally, in some embodiments, since the first optical element is closer to the light source than the second optical element, the light passes through the first optical element before entering the second optical element. In other words, before the light arrives at the second optical element (e.g. the optical sensing element), the light passes through the first optical element and the third optical element **4-950**. After the initial optical zooming and/or optical focusing, the light enters the second optical element. However, it should be noted that, in the embodiments according to the present disclosure, the second optical element is movable relative to the first optical element and the third optical element **4-950**. The relative motion may be used for further optical zooming and/or optical focusing effects.

(203) In some embodiments, the optical element driving mechanism **4-10** further includes a first stopper assembly **4-810**, a second stopper assembly **4-820**, and a third stopper assembly **4-830**. The first stopper assembly **4-810** is located at the first movable portion **4-100** and the fixed portion **4-900**. For example, the first stopper assembly **4-810** may include a plurality of bulges that are located on the top surface of the first movable portion **4-100**. During the motion of the first movable portion **4-100**, when these bulges are in contact with the fixed portion **4-900**, the first movable portion **4-100** may be defined to move within a first range of movement relative to the fixed portion **4-900**. The second stopper assembly **4-820** is located at the first movable portion **4-100** and the third movable portion **4-300**. For example, the first movable portion **4-100** may include a frame **4-150** that surrounds its circumference. The second stopper assembly **4-820** may be located at the surface of the frame **4-150** that faces the second movable portion **4-200** and at the surface of the circuit assembly **4-300** of the third movable portion **4-300** that faces the second movable portion **4-200**. During the motion of the second movable portion **4-200**, when the second movable portion **4-200** is in contact with the frame **4-150** or the circuit assembly **4-330**, the second movable portion **4-200** may be defined to move within a second range of movement relative to the first movable portion **4-100**. The third stopper assembly **4-830** is located at the first movable portion **4-100** and the third movable portion **4-300**. For example, the third stopper assembly **4-830** may be located at the surface of the first movable portion **4-100** that faces the third movable portion **4-300** and at the surface of the circuit assembly **4-300** of the third movable portion **4-300** that faces the first movable portion **4-100**. During the motion of the third movable portion **4-300**, when the circuit assembly **4-330** is in contact with the first movable portion **4-100**, the third movable portion **4-300** may be defined to move within a third range of movement relative to the first movable portion **4-100** and/or the second movable portion **4-200**.

(204) In some embodiments, the size of the first range of movement along the main axis **4-M** is different from the size of the second range of movement along the main axis **4-M**. More

specifically, the size of the first range of movement along the main axis **4-M** is wider than the size of the second range of movement along the main axis **4-M**. These embodiments are adapted to the fact that the stroke distance for optical zooming is usually larger than the stroke distance for optical focusing. In some other embodiments, the sizes of the first range of movement and the second range of movement may be determined based on different requirements.

(205) Additionally, in some embodiments, the optical element driving mechanism **4-10** may further include a first sensing assembly **4-550**, a second sensing assembly **4-630**, and a third sensing assembly **4-680**. The first sensing assembly **4-550** is connected to the second driving assembly **4-500**, for sensing the positions of the second movable portion **4-200** relative to the fixed portion **4-900**. The second sensing assembly **4-630** is connected to the third driving assembly **4-600**, for sensing the translational positions of the third movable portion **4-300** relative to the fixed portion **4-900**. The third sensing assembly **4-680** is connected to the third driving assembly **4-600**, for sensing the rotational positions of the third movable portion **4-300** relative to the fixed portion **4-900**. In some embodiments, the second sensing assembly **4-630** and the third sensing assembly **4-680** may be embedded in the second holder **4-310**, and electrically connected to the circuit assembly **4-330**, as shown in FIG. **30**.

(206) In summary, the optical element driving mechanism **4-10** of the present disclosure includes a plurality of optical elements: the first optical element (e.g. a lens), the second optical element (e.g. an optical sensing element), and the third optical element (e.g. a lens). By using a plurality of driving assemblies (e.g. the first driving assembly **4-400**, the second driving assembly **4-500**, and the third driving assembly **4-600**), through piezoelectric and electromagnetic driving methods, the first optical element and the second optical element are driven to move. In addition to the motion of the lens itself relative to the fixed portion **4-900**, the optical sensing element is also movable and rotatable in the direction that is perpendicular to the optical axis. This is helpful for more precise zooming and/or focusing, achieving better optical effects.

(207) The fifth embodiment of the present disclosure is described below.

(208) FIG. **33** shows a perspective view of a haptic feedback system **5-10** in accordance with some embodiments of the present disclosure. It should be noted first that in this embodiment, the haptic feedback system **5-10** may be, for example, disposed in an electronic device (not shown), and generate a feedback (e.g. haptic feedback) according to different functions. The present disclosure provides a haptic feedback system **5-10** that is capable of providing different vibration modes and achieving miniaturization. As shown in FIG. **33**, the haptic feedback system **5-10** includes a casing **5-110**, a base **5-120** and an outer frame **5-130**. In some embodiments, the outer frame **5-130** is disposed between the casing **5-110** and the base **5-120** such that the casing **5-110**, the base **5-120** and the outer frame **5-130** may form a substantially rectangular housing.

(209) In some embodiments, the thickness of the outer frame **5-130** in the vertical direction (e.g. the Z axis) is less than the dimensions of the casing **5-110** and the base **5-120** in the horizontal direction (e.g. the direction parallel to the X-Y plane). In this way, the size of the haptic feedback system **5-10** in at least one direction may be significantly reduced, thereby achieving miniaturization of the electronic device and the haptic feedback system **5-10** disposed therein. In some embodiments, the casing **5-110**, the base **5-120** and the outer frame **5-130** may be different components (for example, the casing **5-110**, the base **5-120** and the outer frame **5-130** may be separated from each other), thereby reducing the difficulty of assembling the various components inside the haptic feedback system **5-10**. In other embodiments, the outer frame **5-130** may be integrated with the casing **5-110** or the base **5-120** (e.g. the outer frame **5-130** may be integrally formed with the casing **5-110** or the base **5-120**), thereby reducing the assembly steps of the haptic feedback system **5-10**.

(210) FIG. **34** shows an exploded view of the haptic feedback system **5-10** in accordance with some embodiments of the present disclosure. As shown in FIG. **34**, the haptic feedback system **5-10** includes a fixed portion **5-F**, a movable portion **5-M**, a driving assembly **5-190** and a first

connecting assembly **5-160**. In some embodiments, the fixing portion **F** may include a casing **5-110**, a base **5-120** and an outer frame **5-130**, and may be fixedly connected to the electronic device where the haptic feedback system **5-10** is disposed. The movable portion **5-M** is movable relative to the fixed portion **5-F**. In some embodiments, the movable portion **5-M** may include a mode adjustment assembly **5-140** and may be driven by the driving assembly **5-190** to move relative to the fixed portion **5-F**, so as to generate a feedback (e.g. haptic feedback) to the electronic device. The movable portion **5-M** may be movably connected to the fixed portion **5-F** via the first connection assembly **5-160**.

(211) In some embodiments, the outer frame **5-130** may have a first sidewall **5-131** and a second sidewall **5-132** connected to each other. The first sidewall **5-131** and the second sidewall **5-132** may be substantially perpendicular to each other. In some embodiments, a rounded corner may be formed between the first sidewall **5-131** and the second sidewall **5-132**, thereby reducing the probability of damage to the outer frame **5-130** due to collision with other components in the electronic device. In some embodiments, mode adjustment assembly **5-140** includes a frame **5-141**, an adjustment element **5-150** and a second connection assembly **5-170**. The frame **5-141** is connected to the first connection assembly **5-160**. The adjustment element **5-150** may be movably connected to the frame **5-141** via the second connecting assembly **5-170**, so that the adjustment element **5-150** is movable relative to the frame **5-141** and the fixed portion **5-F**. As shown in FIG. In some embodiments, the mass of the adjustment element **5-150** is different from the mass of the frame **5-141**. The detailed structure of the frame **5-141** and the operation of the mode adjustment assembly **5-140** will be further described below with reference to FIG. 35.

(212) In some embodiments, the circuit board **5-180** is disposed on the base **5-120**, and the circuit board **5-180** may include a first portion **5-181** and a second portion **5-182** that are spaced apart from each other. In other words, the first portion **5-181** and the second portion **5-182** are not in direct contact, and a gap is formed between the first portion **5-181** and the second portion **5-182**. In some embodiments, the shapes of the first portion **5-181** and the second portion **5-182** on the base **5-120** are different, but the present disclosure is not limited thereto. The first portion **5-181** and the second portion **5-182** of the circuit board **5-180** may be physically and electrically connected via the driving assembly **5-190** (e.g. a coil **5-191**). In this way, signals can be transmitted between the first portion **5-181** and the second portion **5-182**, thereby reducing the manufacturing cost of the circuit board **5-180**. The circuit board **5-180** may be used to receive or transmit signals between the driving assembly **5-190** (e.g. the coil **5-191**) and external components, so that the mode adjustment assembly **5-140** can generate haptic feedback.

(213) In some embodiments, a metallic sheet **5-183** may be disposed between the first portion **5-181** and the second portion **5-182** to support the drive assembly **5-190** (e.g. the coil **5-191**) connecting the first portion **5-181** and the second portion **5-182**. The metallic sheet **5-183** may be disposed corresponding to the gap between the first portion **5-181** and the second portion **5-182**. For example, the metallic sheet **5-183** may be disposed along the contours of the first portion **5-181** and the second portion **5-182**. For example, the spacing between the metallic sheet **5-183** and the first portion **5-181** (and/or the second portion **5-182**) may be kept constant, but the present disclosure is not limited thereto. The metallic sheet **5-183** may not contact the first portion **5-181** and the second portion **5-182** and be electrically insulated from the first portion **5-181** and the second portion **5-182**. In some embodiments, the metallic sheet **5-183** may not be electrically connected to any conductive element, and will not be used to transmit any signal. In this way, the probability of forming a short circuit between the metallic sheet **5-183** and other conductive elements can be reduced. In some embodiments, the metallic sheet **5-183** may be omitted, or replaced with other insulating materials, and these configurations are within the scope of the present disclosure.

(214) The position sensor **5-185** may be disposed on the circuit board **5-180**. In some embodiments, the position sensor **5-185** may be disposed on the second portion **5-182** and located

inside the coil **5-191** (e.g. surrounded by the coil **5-191**). For example, the position sensor **5-185** may be a Hall effect sensor, and may be located at a position where the second portion **5-182** protrudes toward the first portion **5-181**. The position sensor **5-185** can detect the position of the mode adjustment assembly **5-140**, thereby determining if the parameters related to the transmitted signal and vibration need to be adjusted. However, it should be understood that the above-mentioned configuration is only an example of the present disclosure, and those skilled in the art can derive other similar configurations (for example, setting the position sensor **5-185** on the first portion **5-181** or changing the shape or position of the first portion **5-181** and the second portion **5-182**), and these configurations are all within the scope of the present disclosure.

(215) FIG. **35** shows a perspective view of the interior of the haptic feedback system **5-10** in accordance with some embodiments of the present disclosure. It should be noted that, in order to clearly illustrate the internal structure of the haptic feedback system **5-10**, the casing **5-110** and the outer frame **5-130** will not be shown in this embodiment. As shown in FIG. **35**, the frame **5-141** of the mode adjustment assembly **5-140** has a first side **5-142** and a second side **5-143** that is different from the first side surface **5-142**. In some embodiments, both the first side **5-142** and the second side **5-143** are substantially perpendicular to the top surface of the frame **5-141**. The second connecting assembly **5-170** may connect the outer frame **5-130** (see FIG. **34**) and the second side **5-143** of the frame **5-141**. Accordingly, the frame **5-141** is movable relative to the fixing portion **5-F** (e.g. the outer frame **5-130**).

(216) The first side **5-142** may face the adjustment element **5-150**. The frame **5-141** further has a plurality of protruding portions **5-144** protruding from the first side **5-142**. The protruding portions **5-144** may extend to opposite sides of the adjustment element **5-150**. In this way, the second connecting assembly **5-170** may connect the protruding portion **5-144** and the adjustment element **5-150**, so that the adjustment element **5-150** is movable relative to the frame **5-141**. In addition, the frame **5-141** also has a plurality of stopping portions **5-145** formed on the first side **5-142**, for example, extending from the first side **5-142** toward the second connecting assembly **5-170**. The stopping portions **5-145** can limit the range of motion of the adjustment element **5-150**. In other words, the adjustment element **5-150** is merely movable within the range between the opposing stopping portions **5-145**. A buffer member **5-200** may be disposed on the first side **5-142** and the stopping portions **5-145**. As a result, the adjustment element **5-150** will contact the buffer member **5-200** without directly hitting the frame **5-141** (e.g. the first side **5-142** and the stopping portions **5-145**). For example, the buffer members **5-200** may be made of a material (e.g. rubber or colloid) with a hardness that is less than the hardness of the frame **5-141**, and when the adjustment element **5-150** contacts the buffer member **5-200**, the impact force of the adjustment element **5-150** may be absorbed, and therefore reducing the probability of damage to the overall mode adjustment assembly **5-140**, or reducing the noise generated by the operation of the adjustment element **5-150**.

(217) The adjustment element **5-150** may include a carrier **5-151** and a weighting member **5-155** disposed in the carrier **5-151**. In some embodiments, the carrier **5-151** and the weighting member **5-155** may be made of different materials. For example, the weighting member **5-155** may be made of high density alloys such as tungsten(W)-containing alloys or any other suitable material, while the carrier **5-151** may be made of, for example, plastic or any other suitable material. With the arrangement of the weighting member **5-155**, the adjustment element **5-150** may be arranged with sufficient mass in a limited space, so that the mode adjustment assembly **5-140** may operate in a desired vibration mode. The carrier **5-151** is made of a material that is easy to process, so that the desired appearance of the adjustment element **5-150** may be formed in cooperation with the weighting member **5-155**.

(218) For example, the first connecting assembly **5-160** may be a spring sheet or other elastic elements. In this embodiment, the first connection assembly **5-160** includes a first section **5-161**, a second section **5-162** and a connecting portion **5-163**. For example, the first section **5-161** and the second section **5-162** may be defined as a portion extending substantially along a straight line, and

the connecting portion 5-163 may be defined as a portion connecting the first section 5-161 and the second section 5-162. In some embodiments, the first segment 5-161 may be connected to the outer frame 5-130, the second segment 5-162 may be connected to the frame 5-141 (e.g. connected to the second side 5-143), and the first segment 5-161 and the second segment 5-162 are connected via the connecting portion 5-163. In some embodiments, the extending directions of the first segment 5-161 and the second segment 5-162 are not parallel. By disposing the first connecting assembly 5-160 on opposite sides of the frame 5-141, the frame 5-141 is movable in an axial direction (e.g. in a direction substantially parallel to the X-axis). In some embodiments, the orientations of the connecting portions 5-163 of the first connecting assemblies 5-160 disposed on opposite sides of the frame 5-141 are different. More specifically, the connecting portion 5-163 of one of the first connecting assemblies 5-160 is disposed to face the protruding portions 5-144 of the frame 5-141, and the connecting portion 5-163 of the other first connecting assembly 5-160 is disposed to be away from the protruding portions 5-144 of the frame 5-141. However, the above configurations are only examples and are not intended to limit the scope of the present disclosure.

(219) For example, the second connecting assembly 5-170 may be a spring sheet or other elastic elements. In this embodiment, the second connection assembly 5-170 includes a plurality of first sections 5-171, a plurality of second sections 5-172 and a plurality of connecting portions 5-173. For example, the first sections 5-171 and the second sections 5-172 may be defined as portions extending substantially along a straight line, and the connecting portions 5-173 may be defined as portions connecting the first sections 5-171 and the second sections 5-172. In some embodiments, the first sections 5-171 and the second sections 5-172 are alternately arranged, and each of the first sections 5-171 and each of the second sections 5-172 is connected via a corresponding connecting portion 5-173. In some embodiments, the connecting portion 5-163 and the connecting portion 5-173 are oriented differently. More specifically, the connecting portion 5-173 may face the casing 5-110 or the base 5-120 (see FIG. 34). In some embodiments, the orientation of the connecting portion 5-163 and the orientation of the connecting portion 5-173 may be substantially perpendicular, but the present disclosure is not limited thereto. By arranging the second connecting assemblies 5-170 on opposite sides of the adjustment element 5-150, the adjustment element 5-150 is movable in an axial direction (e.g. in a direction substantially parallel to the X-axis). It should be understood that the above configurations are only examples and are not intended to limit the scope of the present disclosure.

(220) FIG. 36 shows a top view of the interior of the haptic feedback system 5-10 in accordance with some embodiments of the present disclosure. As shown in FIG. 36, the frame 5-141 may include a body 5-141A and a metallic member 5-141B. In some embodiments, the metallic member 5-141B may be formed in the body 5-141A by insert molding. In some embodiments, the hardness of the metallic member 5-141B may be greater than the hardness of the body 5-141A, thereby improving the overall structural strength of the frame 5-141. In this embodiment, the metallic member 5-141B may be exposed on the protruding portion 5-144 of the frame 5-141, and the exposed portion of the metallic member 5-141B may be connected to the second connecting assembly 5-170 in any suitable manner (e.g. by welding, etc.).

(221) In addition, as shown in FIG. 36, the buffer member 5-200 may be disposed between the first section 5-161 and the second section 5-162 of the first connection assembly 5-160 to provide the buffer between the first section 5-161 and the second section 5-162, reducing the probability of damage to the first connecting assembly 5-160. In this embodiment, the buffer member 5-200 may be disposed on the first section 5-161, but the present disclosure is not limited thereto. In other embodiments, the buffer member 5-200 may also be disposed on the second section 5-162 (between the first section 5-161 and the second section 5-162), or on the connecting portion 5-163 (located between the connecting portion 5-163 and the frame 5-141). These embodiments are intended to be included within the scope of the present disclosure. With the configuration of the buffer element 5-200, the service life of the first connection assembly 5-160 and/or the mode

adjustment assembly **5-140** may be prolonged, or the noise generated by the mode adjustment assembly **5-140** during operation may be reduced.

(222) The circuit board **5-180** may generate a signal or receive a signal from the outside, and transmit the signal to the driving assembly **5-190** (the coil **5-191**), and therefore the coil **5-191** and the magnetic element of the driving assembly **5-190** can generate a driving force to drive the movable portion **5-M** to move relative to the fixed portion **5-F**. Since the driving force has a specific frequency, the mode adjustment assembly **5-140** of the movable portion **5-M** is caused to resonate, so that the mode adjustment assembly **5-140** vibrates, forming a vibration mode. In this way, the haptic feedback system **5-10** can achieve the function of generating haptic feedback. In some embodiments, the circuit board **5-180** may extend beyond the projection range of the frame **5-141** on the X-Y plane. For example, the circuit board **5-180** may be closer to the outer frame **5-130** (see FIG. **34**) than the frame **5-141**, but the present disclosure is not limited thereto.

(223) For example, the coil **5-191** may receive a first signal, wherein the first signal has a first frequency, and causes the movable portion **5-M** to have a first vibration mode relative to the fixed portion **5-F**. In this embodiment, the first frequency is the same as the frequency of the first vibration mode. More specifically, when the movable portion **5-M** moves in the first vibration mode, the movable portion **5-M** (e.g. the frame **5-141**) is movable (e.g. in a linear motion) relative to the fixed portion **5-F** in a first dimension (e.g. along a direction substantially parallel to the X-axis). Meanwhile, the adjustment element **5-150** is movable relative to the frame **5-141** in a first movement manner, and the frequency of the first movement manner is substantially the same as the frequency of the first vibration mode. When the adjustment element **5-150** moves relative to the frame **5-141** in the first movement manner, the adjustment element **5-150** is movable (for example, linear motion) in a second dimension (for example, in a direction substantially parallel to the X-axis). When the movable portion **5-M** moves in the first vibration mode, a first phase difference exists between the movement of the frame **5-141** relative to the fixed portion **5-F** and the movement of the adjustment element **5-150** relative to the frame **5-141**. For example, the frame **5-141** and the adjustment element **5-150** may reach the extreme position in the direction of the positive X-axis (that is, the farthest position relative to the center of the haptic feedback system **5-10** that is reachable in this direction). The phase difference between the movement of the frame **5-141** and the movement of the adjustment element **5-150** may be approximately 0 degrees.

(224) The movable portion **5-M** may have a second vibration mode relative to the fixed portion **5-F** by setting the mode adjustment assembly **5-140**, wherein the frequency of the first vibration mode and the frequency of the second vibration mode are different. For example, the coil **5-191** may receive a second signal, wherein the second signal has a second frequency, and causes the movable portion **5-M** to have a second vibration mode relative to the fixed portion **5-F**. In this embodiment, the second frequency is the same as the frequency of the second vibration mode. When the movable portion **5-M** moves in the second vibration mode, the movable portion **5-M** moves relative to the fixed portion **5-F** in the first dimension (e.g. along a direction substantially parallel to the X-axis). At this time, the adjustment element **5-150** moves relative to the frame **5-141** in a second movement manner, and the frequency of the second movement manner is the same as the frequency of the second vibration mode. When the adjustment element **5-150** moves relative to the frame **5-141** in the second movement manner, the adjustment element **5-150** moves in the second dimension (e.g. in a direction substantially parallel to the X-axis). When the movable portion **5-M** moves relative to the frame **5-141** in the second vibration mode, a second phase difference exists between the movement of the frame **5-141** relative to the fixed portion **5-F** and the movement of the adjustment element **5-150** relative to the frame **5-141**, and the first phase difference and the second phase difference are different. For example, when the frame **5-141** reaches the extreme position in the direction of the positive X-axis, the adjustment element **5-150** may reach the extreme position in the direction of the negative X-axis, and the phase difference between the movement of the frame **5-141** and the movement of the adjustment element **5-150** may be about 90 degrees. In some

embodiments, the difference between the first phase difference and the second phase difference is greater than 45 degrees, but the present disclosure is not limited thereto.

(225) As set forth above, since the movement of the frame **5-141** and the adjustment element **5-150** may have different phase differences, the movable portion **5-M** of the haptic feedback system **5-10** can generate different vibration modes, thereby achieving the effect of generating different types of haptic feedback. It should be understood that, although the above embodiments illustrate two vibration modes, those skilled in the art should be able to derive other or more vibration modes according to the content of the present disclosure. The vibration modes that are achievable by the disclosed structures are all within the scope of the present disclosure.

(226) FIG. **37** shows a bottom view of the frame **5-141** of the mode adjustment assembly **5-140** in accordance with some embodiments of the present disclosure. As shown in FIG. **37**, the frame **5-141** has a plurality of grooves **5-146**, **5-147** and **5-148** for containing different components. In some embodiments, the driving assembly **5-190** may include a first magnetic element **5-192** and a pair of second magnetic elements **5-193**, which may generate a driving force with the coil **5-191** to drive the mode adjustment assembly **5-140**. In some embodiments, the magnetic pole directions of the first magnetic element **5-192** and the second magnetic elements **5-193** may be different. For example, the magnetic pole direction of the first magnetic element **5-192** may be directed toward the negative Y-axis direction, and the magnetic pole direction of the second magnetic elements **5-193** may be directed toward the positive Y-axis direction, but the present disclosure is not limited thereto. For the brevity of the description, other magnetic pole configurations of the first magnetic element **5-192** and the second magnetic elements **5-193** will not be listed separately, but all possible magnetic pole configurations are included within the scope of the present disclosure.

(227) In this embodiment, the first magnetic element **5-192** is contained in the groove **5-146**, and the second magnetic elements **5-193** are each accommodated in one of the grooves **5-147**. It should be noted that, in some embodiments, the first magnetic element **5-192**, the second magnetic elements **5-193**, and the corresponding grooves **5-146** and **5-147** are not completely fitted, that is, there may be gaps between the first magnetic element **5-192** and the groove **5-146** (e.g. in the corners of the groove **5-146**), and there may be gaps between the second magnetic elements **5-193** and the grooves **5-147** (e.g. in the corners of the grooves **5-147**). In this way, the assembly difficulty of the first magnetic element **5-192** and the second magnetic elements **5-193** may be reduced.

(228) The mode adjustment assembly **5-140** further includes weighting members **5-149**. In some embodiments, frame **5-141** (e.g. body **5-141A**) and the weighting members **5-149** may be made of different materials. For example, the weighting members **5-149** may be made of high density alloys such as tungsten (W)-containing alloys or any other suitable material, while the body **5-141A** of the frame **5-141** may be made of, for example, plastic or any other suitable material. With the arrangement of the weighting members **5-149**, the mode adjustment assembly **5-140** may be arranged with sufficient mass in a limited space, so that the mode adjustment assembly **5-140** can operate in a required vibration mode. The body **5-141A** is made of an easy-to-process material, so that the desired shape of the mode adjustment assembly **5-140** can be obtained by combining the body **5-141A** with the weighting members **5-149**. In this embodiment, the weighting members **5-149** are each contained in one of the grooves **5-148**. Similarly, the weighting members **5-149** and the corresponding grooves **5-148** are not fully fitted, i.e. there may be gaps between the weighting members **5-149** and the grooves **5-148** (e.g. in the corners of the grooves **5-148**). In this way, the assembly difficulty of the weighting members **5-149** can be reduced.

(229) FIG. **38** shows a cross-sectional view of the haptic feedback system **5-10** along line **5-A-5-A** shown in FIG. **33** in accordance with some embodiments of the present disclosure. As shown in FIG. **38**, multiple buffer members **5-200** are provided around the adjustment element **5-150**. For example, the buffer members **5-200** may be disposed on the surfaces of the outer frame **5-130**, the base **5-120** and the frame **5-141**, wherein these surfaces face the adjustment element **5-150**. In

some embodiments, the buffer members **5-200** may also be disposed on the surface of the casing **5-110** facing the adjustment element **5-150**, so as to further reduce the probability of the adjustment element **5-150** colliding with surrounding elements. In some embodiments, the thickness of the buffer member **5-200** disposed on the base **5-120** may be greater than the thickness of the circuit board **5-180**, and the thicknesses of the buffer member **5-200** and the circuit board **5-180** may be measured along a direction that is substantially parallel to the Z-axis, for example. In this way, the probability of the circuit board **5-180** being struck by the adjustment element **5-150** can be reduced. (230) In some embodiments, the metallic member **5-141B** of the frame **5-141** may partially overlap the first magnetic element **5-192** in a direction that is substantially parallel to the Z-axis. For example, the shortest distance between the metallic member **5-141B** and the first side **5-142** may be smaller than the shortest distance between the first magnetic element **5-192** and the first side **5-142**. These shortest distances may be measured along a direction that is parallel to the Y-axis, for example, but the present disclosure is not limited thereto. In some embodiments, the metallic member **5-141B** may completely overlap the first magnetic element **5-192** in a direction that is substantially parallel to the Z-axis. In addition, as shown in FIG. 38, the weighting member **5-149** may be disposed lower than the first magnetic element **5-192**, and therefore the weighting member **5-149** may be closer to the coil **5-191** than the first magnetic element **5-192**.

(231) FIG. 39 shows a perspective view of the adjustment element **5-150** in accordance with some embodiments of the present disclosure. As shown in FIG. 39, the carrier **5-151** of the adjustment element **5-150** includes a body **5-151A** and a metallic member **5-151B** embedded in the body **5-151A**. The metallic member **5-151B** may be formed in the body **5-151A** by insert molding. In some embodiments, the hardness of the metallic member **5-151B** may be greater than the hardness of the body **5-151A**, thereby improving the overall structural strength of the carrier **5-151**. The carrier **5-151** has a recess **5-152** configured to contain the weighting member **5-155**. Similarly, the weighting member **5-155** and the corresponding recess **5-152** are not fully fitted, that is, there may be gaps between the weighting member **5-155** and the recess **5-152** (e.g., in the corners of the recess **5-152**). In some embodiments, the recess **5-152** may be disposed to face the outer frame **5-130**, that is, the recess **5-152** cannot be seen when viewed from the first surface **5-142** of the frame **5-141** to the adjustment element **5-150**. In some embodiments, a bevel structure **5-153** may be disposed on the outer edges of the recess **5-152**, and the above configuration can reduce the difficulty of disposing the weighting member **5-155**, but the present disclosure is not limited thereto. In other embodiments, the bevel structure **5-153** may be omitted, thereby reducing the difficulty of manufacturing the carrier **5-151**.

(232) FIG. 40 shows a cross-sectional view of the adjustment element **5-150** along line 5-B-5-B shown in FIG. 35 in accordance with some embodiments of the present disclosure. As shown in FIG. 40, the second connecting assembly **5-170** further includes an extension portion **5-174** connected to the second section **5-172**. In this embodiment, the metallic member **5-151B** may be partially exposed from the body **5-151A**, and the exposed portion of the metallic member **5-151B** may be connected to the extension portion **5-174** of the second connecting assembly **5-170** in any suitable manner (e.g. by welding, etc.). In addition, in this cross-sectional view, the metallic member **5-151B** may have a non-linear profile within the carrier **5-151**. More specifically, the metallic member **5-151B** may be located higher (compared to the exposed portion of the metallic member **5-151B**) at a position corresponding to the weighting member **5-155** and wrapped by the body **5-151A**. In some embodiments, a portion of the metallic member **5-151B** corresponding to the weighting member **5-155** and another portion of the metallic member **5-151B** not corresponding to the weighting member **5-155** are located on different planes. In this way, the structural strength of the carrier **5-151** may be improved to bear the weight of the weighting member **5-155**.

(233) In summary, the present disclosure provides a haptic feedback system with different vibration modes. The movable portion and the fixed portion may have vibration modes with different

frequencies by setting the mode adjustment assembly. Because the driving assembly receives signals of different frequencies, different phase differences may exist between the movements of the frame and the adjustment element of the mode adjustment assembly, thereby achieving different vibration modes. In addition, a plurality of buffer members are arranged around the movable range of the movable portion, thereby prolonging the service life of the haptic feedback system or reducing the noise generated when the haptic feedback system operates.

(234) The sixth embodiment of the present disclosure is described below.

(235) First, refer to FIG. 41 to FIG. 43. FIG. 41 is a perspective view of a haptic feedback system 6-1 according to an embodiment of the present disclosure. FIG. 42 is an exploded view of a haptic feedback system 6-1 according to an embodiment of the present disclosure. FIG. 43 is a cross-sectional view of the haptic feedback system cut along the line 6-A-6-A in FIG. 41. The haptic feedback system 6-1 may be widely set in various devices, such as smart phones, wearable devices, gamepads, game consoles, tablets, etc., so that the devices may use the vibration of the haptic feedback system 6-1 as information feedback. The haptic feedback system 6-1 includes a fixed portion 6-100, a movable portion 6-200, a connecting assembly 6-300, a driving assembly 6-400, a circuit assembly 6-500, a position sensing assembly 6-600, a plurality of buffer elements 6-700, and a plurality of damping elements 6-800.

(236) The fixed portion 6-100 is fixedly connected to any of the above-mentioned devices, and includes an upper cover 6-110 and a base 6-120. The upper cover 6-110 has a first surface 6-111, a second surface 6-112, a third surface 6-113, a fourth surface 6-114, and a top surface 6-115. The first surface 6-111 is opposite to the third surface 6-113, and the second surface 6-112 is opposite to the fourth surface 6-114. The top surface 6-115 is rectangular and has a length 6-L and a width 6-W. The first surface 6-111, the second surface 6-112, the third surface 6-113, and the fourth surface 6-114 have a height 6-H. The first surface 6-111, the second surface 6-112, the third surface 6-113, and the fourth surface 6-114 extend from the top surface 6-115 along a first direction 6-D1 toward the base 6-120. The height 6-H is smaller than the length 6-L and the width 6-W. Therefore, the haptic feedback system is formed to a flat structure, which is beneficial to the miniaturization of the device.

(237) The movable portion 6-200 is movable relative to the fixed portion 6-100 along a first mode direction 6-Dr1 and a second mode direction 6-Dr2, and is movably connected to the fixed portion 6-100 via the connecting assembly 6-300. The movable portion 6-200 includes a main body 6-210 and a plurality of counterweight elements 6-220. The main body 6-210 is disposed inside the upper cover 6-110 and has a first side 6-211, a second side 6-212, a third side 6-213, a fourth side 6-214, a first recessed portion 6-215, a second recessed portion 6-216, a first accommodating portion 6-217, and a plurality of second accommodating portions 6-218. The first side 6-211, the second side 6-212, the third side 6-213, and the fourth side 6-214 are respectively opposite to the first surface 6-111, the second surface 6-112, the third surface 6-113, and the fourth surface 6-114.

(238) The first recessed portion 6-215 is recessed from the first side 6-211 along a second direction 6-D2 away from the first surface 6-111, and the second recessed portion 6-216 is recessed from the third side 6-213 along the second direction 6-D2 away from the third surface 6-113. The first accommodating portion 6-217 and the second accommodating portions 6-218 pass through the movable portion 6-200 along the first direction 6-D1. When viewed along a third direction 6-D3, the first accommodating portion 6-217 and the second accommodating portions 6-218 at least partially overlap. The second direction 6-D2 is perpendicular to the first direction 6-D1, and the third direction 6-D3 is perpendicular to the first direction 6-D1 and the second direction 6-D2.

(239) The counterweight elements 6-220 are respectively disposed in the second accommodating portions 6-218. The counterweight elements 6-220 and the main body 6-210 are made of different materials. For example, the weight element 6-220 may be made of high density metal, such as an alloy containing tungsten (W) or any other suitable material, while the body 6-210 may be made of, for example, plastic or any other suitable material. With the arrangement of the counterweight

element **6-220**, sufficient mass may be configured in a limited space, so that the movable portion **6-200** may operate in a required mode of vibration, thereby enhancing the vibration feedback felt by the user.

(240) The connecting assembly **6-300** includes a first elastic element **6-310** and a second elastic element **6-320**. The first elastic element **6-310** has a first segment **6-311**, a second segment **6-312**, a third segment **6-313**, a first bending portion **6-314**, a second bending portion **6-315**, a first connecting portion **6-316**, and a second connecting portion **6-317**. The first segment **6-311** is connected to the second segment **6-312** via the first bending portion **6-314**, and the second segment **6-312** is connected to the third segment **6-313** via the second bending portion **6-315**. The first connecting portion **6-316** connects the first segment **6-311** and the fixed portion **6-100**, and the second connecting portion **6-317** connects the third segment **6-313** and the movable portion **6-200**.

(241) The first segment **6-311**, the second segment **6-312**, and the third segment **6-313** are not parallel to each other. The first bending portion **6-314** has a first bending angle $6-\theta_1$, and the second bending portion **6-315** has a second bending angle $6-\theta_2$. The first segment **6-311** has a first length, the second segment **6-312** has a second length, and the third segment **6-313** has a third length. In some embodiments, the first bending angle $6-\theta_1$ is smaller than the second bending angle $6-\theta_2$, and the first length is longer than the second length, and the third length is longer than the second length, but not limited this, which may be changed as required.

(242) The second elastic element **6-320** has the same structure as the first elastic element **6-310**, and has a first segment **6-321**, a second segment **6-322**, a third segment **6-323**, a first bending portion **6-324**, a second bending portion **6-325**, a first connecting portion **6-326**, and a second connecting portion **6-327**. When viewed along the first direction **6-D1**, the first elastic element **6-310** and the second elastic element **6-320** are symmetrically disposed.

(243) In more detail, the first connecting portion **6-316** of the first elastic element **6-310** is connected to the fourth surface **6-114** of the upper cover **6-110**, and the second connecting portion **6-317** of the first elastic element **6-310** is connected to the third surface **6-113** of the upper cover **6-110**. The first connecting portion **6-326** of the second elastic element **6-320** is connected to the second surface **6-112** of the upper cover **6-110**, and the second connecting portion **6-327** of the second elastic element **6-320** is connected to the first surface **6-111** of the upper cover **6-110**. The first segment **6-311** and the second segment **6-312** of the first elastic element **6-310** are disposed between the fourth surface **6-114** of the upper cover **6-110** and the fourth side **6-214** of the movable portion **6-200**. The third segment **6-313** of the first elastic element **6-310** is disposed between the third surface **6-113** of the upper cover **6-110** and the second recessed portion **6-216** of the movable portion **6-200**. The first segment **6-321** and the second segment **6-322** of the second elastic element **6-320** are disposed between the second surface **6-112** of the upper cover **6-110** and the second side **6-212** of the movable portion **6-200**. The third segment **6-323** of the second elastic element **6-320** is disposed between the first surface **6-111** of the upper cover **6-110** and the first recessed portion **6-215** of the movable portion **6-200**.

(244) In some embodiments, at least one of the first segments **6-311**, **6-321** and the second segments **6-312**, **6-322** of the first elastic element **6-310** and the second elastic element **6-320** is provided with a hollow pattern **6-P**. In some embodiments, the first segments **6-311**, **6-321** and the second segments **6-312**, **6-322** are all provided with hollow patterns **6-P**, so as to adjust the resonance frequency and vibration response of the first elastic element **6-310** and the second elastic element **6-320**.

(245) Next, refer to FIG. 41 to FIG. 44. FIG. 44 is a schematic diagram of partial elements of a haptic feedback system **6-1** according to an embodiment of the present disclosure. The driving assembly **6-400** drives the movable portion **6-200** to move relative to the fixed portion **6-100** by a driving force, wherein a driving direction **6-Df** of the driving force is different from the first mode direction **6-Dr1** and the second mode direction **6-Dr2**, which will be described in detail later. The driving assembly **6-400** includes a driving magnet group **6-410**, a driving coil group **6-420**, and a

magnetic permeable plate **6-430**. The driving magnet group **6-410** is disposed on the first accommodating portion **6-217** of the movable portion **6-200**, and the driving coil group **6-420** is disposed on the base **6-120** of the fixed portion **6-100** and partially accommodated in the first accommodating portion **6-217**. When viewed along the first direction **6-D1**, the driving magnet group **6-410** and the driving coil group **6-420** do not overlap.

(246) The driving magnet group **6-410** includes at least two magnetic elements **6-411**, which are symmetrically disposed on two inner walls of the first accommodating portion **6-217**. Each of the two magnetic elements **6-411** includes at least three magnetic units **6-411A**, as shown in FIG. **44**. FIG. **44** is a schematic diagram showing the configuration of the magnetic units **6-411A** disposed in the magnetic element **6-411** and the driving coil set **6-420**. The magnetic units **6-411A** are arranged along the third direction **6-D3**. The magnetic pole directions of any two adjacent magnetic units **6-411A** are different.

(247) The driving coil set **6-420** includes a first coil **6-421**, a second coil **6-422**, and a magnetic permeable element **6-423**. The first coil **6-421** and the second coil **6-422** are wound around the magnetic permeable element **6-423**. The magnetic permeable element **6-423** has a shaft portion **6-423A** and a partition portion **6-423B**. The shaft portion **6-423A** extends along the third direction **6-D3**, and the partition portion **6-423B** separates the first coil **6-421** from the second coil **6-422**. A first winding direction **6-Dw1** of the first coil **6-421** is different from a second winding direction **6-Dw2** of the second coil **6-422**. For example, in some embodiments, one of the first coil **6-421** and the second coil **6-422** winds around the shaft portion **6-423A** in a clockwise direction, and the other one of the first coil **6-421** and the second coil **6-422** winds around the shaft portion **6-423A** in a counterclockwise direction. With the configuration of the magnetic unit **6-411A**, the first coil **6-421** and the second coil **6-422**, the magnetic field along the third direction **6-D3** may be stronger, thereby making the driving force along the third direction **6-D3** larger. Therefore, a vibration amplitude may be increased.

(248) The magnetic permeable plate **6-430** has a rectangular shape and is disposed between the movable portion **6-200** and the top surface **6-115** of the upper cover **6-110** for magnetic permeability. In addition, the magnetic permeable plate **6-430** may be used as a bearing surface of the movable portion **6-200** relative to the upper cover **6-110**. The magnetic field may be increased with the magnetic permeable plate **6-430**, so that the driving force may be increased, and the vibration amplitude may be increased. Moreover, it may also make it easier to assemble the driving magnet group **6-410** and the counterweight elements **6-220**. When viewed along the first direction **6-D1**, the magnetic permeable plate **6-430** at least partially overlaps with the driving magnet group **6-410**.

(249) The circuit assembly **6-500** and the position sensing assembly **6-600** are used to control the movable portion **6-200** in closed-loop. The circuit assembly **6-500** includes a circuit board **6-510** and a plurality of IC elements **6-520** (for simplicity, only one IC element **6-520** is shown in FIG. **42**) disposed on the circuit board **6-510**. The circuit board **6-510** is disposed on the base **6-120** of the fixed portion **6-100**. The position sensing assembly **6-600** is connected to the circuit board **6-510** and senses the movement of the movable portion **6-200** relative to the fixed portion **6-100**, and includes a reference element **6-610** and a position sensing element **6-620**. In some embodiments, the reference element **6-610** is a magnetic element disposed on the movable portion **6-200**, and the position sensing element **6-620** may be, for example, a Hall effect sensor, a magnetic resistance sensor, or a Fluxgate, etc., and is disposed on the circuit board **6-510** to sense the magnetic field of the reference element **6-610** disposed on the movable portion **6-200**, so as to obtain the position of the movable portion **6-200** relative to the fixed portion **6-100**. The reference element **6-610** and the position sensing element **6-620** at least partially overlap when viewed along the first direction **6-D1**.

(250) Next, refer to FIG. **42**, FIG. **43**, and FIG. **45**. FIG. **45** is a schematic diagram of partial elements of a haptic feedback system **6-1** according to an embodiment of the present disclosure.

The buffer elements **6-700** may include gel or damping oil to reduce impact damage or noise generated when the haptic feedback system **6-1** operates. The buffer elements **6-700** are disposed between the fixed portion **6-100** and the movable portion **6-200**. For example, when viewed along the first direction **6-D1**, the first accommodating portion **6-217** of the movable portion **6-200** is a rectangle, and four of the buffer elements **6-700** may be disposed at four corners of the first accommodating portion **6-217** to prevent the movable portion **6-200** directly strikes the driving coil set **6-420** disposed on the fixed portion **6-100**.

(251) In addition, by the configuration of the first recessed portion **6-215** and the second recessed portion **6-216**, there is a buffer distance between the connecting assembly **6-300** and the movable portion **6-200**. In addition, two corners of the movable portion **6-200** close to the connecting assembly **6-300** are designed to be a non-right angle, and one of the buffer elements **6-700** is disposed between the first recessed portion **6-215** (and/or the second recessed portion **6-216**) of the movable portion **6-200** and the connecting assembly **6-300** (two corners described above), which may prevent the movable portion **6-200** from hitting the connecting assembly **6-300** and breaking the connecting assembly **6-300**.

(252) The damping elements **6-800** may include gel or damping oil, etc., to accelerate the response speed of the haptic feedback system **6-1**, so that the haptic feedback system **6-1** may achieve the effect of quick start and quick stop. The damping elements **6-800** are disposed between the fixed portion **6-100** and the movable portion **6-200**. For example, at least one of the damping elements **6-800** may be disposed between the movable portion **6-200** and the base **6-120**. And at least one of the damping elements **6-800** may be disposed between the movable portion **6-200** and the first coil **6-421** (and/or the second coil **6-422**) of the driving assembly **6-400**.

(253) Next, the operation of the haptic feedback system **6-1** will be described with reference to FIG. 43. The movable portion **6-200** has a first natural frequency (more specifically, the combination of the movable portion **6-200** and the connecting assembly **6-300** has a first natural frequency), when the driving assembly **6-400** drives the movable portion **6-200** at a first exciting frequency, and when the first exciting frequency is equal to the first natural frequency, the movable portion **6-200** has a first mode of vibration relative to the fixed portion **6-100** and moves along the first mode direction **6-Dr1**.

(254) In addition, the movable portion **6-200** has a second natural frequency (more specifically, the combination of the movable portion **6-200** and the connecting assembly **6-300** has a second natural frequency), when the driving assembly **6-400** drives the movable portion **6-200** with a second exciting frequency, and when the second exciting frequency is equal to the second natural frequency, the movable portion **6-200** has a second mode of vibration relative to the fixed portion **6-100** and moves along the second mode direction **6-Dr2**.

(255) As mentioned above, the mass of the counterweight element **6-220** of the movable portion **6-200** can be changed, or the hollow pattern **6-P** or the thickness of the connecting assembly **6-300** can be changed, thereby changing natural frequencies of the combination of the movable portion **6-200** and the connecting assembly **6-300**. In this embodiment, the above variable factors are controlled so that the first mode direction **6-Dr1** and the second mode direction **6-Dr2** are different and not parallel. More specifically, the first mode direction **6-Dr1** and the second mode direction **6-Dr2** are perpendicular to the first direction **6-D1**. In addition, in this embodiment, the driving direction **6-Df** is perpendicular to the first direction **6-D1**, and the driving direction **6-Df** is neither parallel nor perpendicular to the first mode direction **6-Dr1** and the second mode direction **6-Dr2**.

(256) The movable portion **6-200** is subjected to two kinds of forces during the movement. One is the driving force, which is caused by the mutual interaction of magnetic fields between the driving magnet group **6-410** disposed on the movable portion **6-200** and the driving coil group **6-420** disposed on the fixed portion **6-100**. The other one is the elastic restoring force of the first elastic element **6-310** and the second elastic element **6-320**, and the elastic restoring force generated by the deformation of the first elastic element **6-310** and the second elastic element **6-320** under the

movement of the movable portion **6-200**.

(257) In this embodiment, by the structural design of the first elastic element **6-310** and the second elastic element **6-320**, that is, the first elastic element **6-310** and the second elastic element **6-320** respectively have the first segment **6-311**, **6-321**, the second segments **6-312**, **6-322**, and the third segments **6-313**, **6-323**, so that the first elastic element **6-310** and the second elastic element **6-320** are bent and deformed by the movement of the movable portion **6-200**. Therefore, there is a deformed component in the direction that is parallel to the driving force while there is another deformed component in the direction that is perpendicular to the driving force. Thus, when the driving force is applied to the movable portion **6-200** by the driving assembly **6-400**, even if the driving direction **6-Df** of the driving force is not along the first mode direction **6-Dr1** or the second mode direction **6-Dr2**, the movable portion **6-200** may move along the first mode direction **6-Dr1** at the first exciting frequency and may move along the second mode direction **6-Dr2** at the second exciting frequency because of the structure of the connecting assembly **6-300** mentioned above. Therefore, vibration in multiple directions may be generated by only one haptic feedback system **6-1**, thus enhancing functions of the device, and light weight and low cost may be achieved.

(258) In addition, the extension length, the first bending angle $\theta 1$, and the second bending angle $\theta 2$ of the first segment **6-311**, **6-321**, the second segment **6-312**, **6-322**, and the third segment **6-313**, **6-323** may also affect components of the vibration amplitude of the movable portion **6-200** in the second direction **6-D2** and the third direction **6-D3**. Therefore, changing the length and angle between the segments may make the haptic feedback system **6-1** meet the components of vibration amplitude in different directions required by the device, thereby achieving custom products.

(259) To sum up, the present disclosure provides a haptic feedback system, which is disposed in a device and includes a fixed portion, a movable portion, a connecting assembly, and a driving assembly. The fixed portion fixedly connects the device. The movable portion is movable along a first mode direction and a second mode direction relative to the fixed portion. The movable portion is movably connected to the fixed portion via the connecting assembly. The driving assembly drives the movable portion to move relative to the fixed portion by a driving force. The haptic feedback system of the present disclosure may make the movable portion move along the first mode direction or the second mode direction by the driving force along the same driving direction.

(260) Although some embodiments of the present disclosure and their advantages have been described in detail, it should be understood that various changes, substitutions and alterations can be made herein without departing from the spirit and scope of the disclosure as defined by the appended claims. For example, it will be readily understood by those skilled in the art that many of the features, functions, processes, and materials described herein may be varied while remaining within the scope of the present disclosure. Moreover, the scope of the present application is not intended to be limited to the particular embodiments of the process, machine, manufacture, compositions of matter, means, methods and steps described in the specification. As one of ordinary skill in the art will readily appreciate from the disclosure of the present disclosure, processes, machines, manufacture, compositions of matter, means, methods, or steps, presently existing or later to be developed, that perform substantially the same function or achieve substantially the same result as the corresponding embodiments described herein may be utilized according to the present disclosure. Accordingly, the appended claims are intended to include within their scope such processes, machines, manufacture, compositions of matter, means, methods, or steps. Moreover, the scope of the appended claims should be accorded the broadest interpretation so as to encompass all such modifications and similar arrangements.

(261) While the invention has been described by way of example and in terms of preferred embodiment, it should be understood that the invention is not limited thereto. On the contrary, it is intended to cover various modifications and similar arrangements (as would be apparent to those skilled in the art). Therefore, the scope of the appended claims should be accorded the broadest interpretation to encompass all such modifications and similar arrangements.

Claims

1. A tactile feedback system, disposed in an electronic device, comprising: a fixed part, affixed to the electronic device; a movable part, movably connected to the fixed part; a driving assembly, driving the movable part to move relative to the fixed part and generating a tactile feedback force to a user; and a control unit, transmitting a control signal to the driving assembly for driving the movable part to move relative to the fixed part, wherein the electronic device has a CPU and a sensing module, and the sensing module is disposed outside the tactile feedback system and transmits a first sensing signal to the CPU, wherein the CPU transmits a command signal to the control unit so that the control unit is adjusted to a specific control mode, wherein the sensing module further transmits a second sensing signal to the control unit without passing through the CPU, wherein a first curve is obtained by an external equipment measuring a motion of the movable part and the second sensing signal generated by the sensing module corresponding to the motion of the movable part, and the first curve represents the relationship between the motion of the movable part and the second sensing signal, and wherein the external equipment modifies a setting parameter of the control unit according to the first curve.
2. The tactile feedback system as claimed in claim 1, wherein the sensing module is disposed on a flat member of the electronic device, and the fixed part is affixed to the flat member, wherein the tactile feedback system electrically connects to the sensing module via a circuit assembly that is disposed on the flat member.
3. The tactile feedback system as claimed in claim 1, further comprising a sensor element, disposed in or on the fixed part for detecting a motion of the movable part, wherein the sensor element transmits a third sensing signal to the control unit, and the control unit transmits the control signal to the driving assembly according to the second and third sensing signals.
4. The tactile feedback system as claimed in claim 3, wherein a second curve is obtained by the external equipment measuring the motion of the movable part and the third sensing signal generated by the sensor element corresponding to the motion of the movable part, and the second curve represents the relationship between the motion of the movable part and the third sensing signal.
5. The tactile feedback system as claimed in claim 3, wherein the sensor element comprises a Hall sensor.
6. The tactile feedback system as claimed in claim 1, wherein the CPU transmits the command signal to the control unit according to the first sensing signal, and the control unit transmits the control signal to the driving assembly according to command signal.
7. The tactile feedback system as claimed in claim 6, wherein the control unit transmits the control signal to the driving assembly according to command signal and the second sensing signal.
8. The tactile feedback system as claimed in claim 1, wherein the tactile feedback system performs a closed-loop motion control to the movable part according to the second sensing signal.
9. The tactile feedback system as claimed in claim 1, wherein when the second sensing signal meets a first condition, the control unit controls the movable part to move in a first mode via the driving assembly, and when the second sensing signal meets a second condition, the control unit controls the movable part to move in a second mode via the driving assembly.
10. The tactile feedback system as claimed in claim 1, wherein the driving assembly includes a coil disposed on the fixed part and a magnet disposed on the movable part.
11. The tactile feedback system as claimed in claim 1, wherein the sensing module constitutes at least a part of a user interface of the electronic device.
12. The tactile feedback system as claimed in claim 1, wherein the second sensing signal is greater than or less than the first sensing signal.
13. The tactile feedback system as claimed in claim 1, wherein the second sensing signal is equal to

the first sensing signal.

14. The tactile feedback system as claimed in claim 1, wherein the fixed part, the movable part, and the driving assembly constitute at least a part of a linear resonant actuator (LRA).
